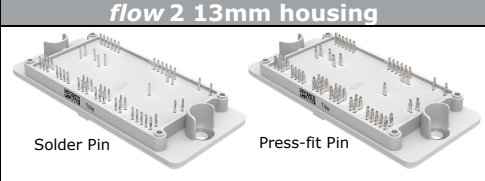
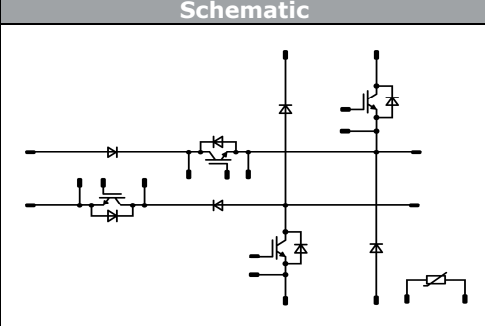




| <i>flow 2</i> MNPC                                                                                                                                                                                                                          |  | 1200 V / 160 A                                                                                                |  |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|---------------------------------------------------------------------------------------------------------------|--|
| <b>Features</b> <ul style="list-style-type: none"> <li>• Mixed voltage NPC topology</li> <li>• Reactive power capability</li> <li>• Low inductance layout</li> <li>• Split output</li> <li>• Common collector neutral connection</li> </ul> |  | <b>flow 2 13mm housing</b>  |  |
| <b>Target Applications</b> <ul style="list-style-type: none"> <li>• Solar inverter</li> <li>• UPS</li> <li>• Active frontend</li> </ul>                                                                                                     |  | <b>Schematic</b>            |  |
| <b>Types</b> <ul style="list-style-type: none"> <li>• 30-FT12NMA160SH02-M669F28</li> <li>• 30-PT12NMA160SH02-M669F28Y</li> </ul>                                                                                                            |  |                                                                                                               |  |

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

| Parameter                           | Symbol               | Condition                                                 | Value     | Unit             |
|-------------------------------------|----------------------|-----------------------------------------------------------|-----------|------------------|
| <b>Buck Inverse Diode</b>           |                      |                                                           |           |                  |
| Repetitive peak reverse voltage     | $V_{RRM}$            |                                                           | 1200      | V                |
| DC forward current                  | $I_F$                | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                     | 17        | A                |
| Maximum repetitive forward current  | $I_{FRM}$            | $t_p = 10\text{ ms}$                                      | 14        | A                |
| $I^2t$ -value                       | $I^2t$               | $T_j = T_{jmax}$                                          | 40        | A <sup>2</sup> s |
| Power dissipation                   | $P_{tot}$            | $T_s = 80\text{ °C}$                                      | 40        | W                |
| Maximum Junction Temperature        | $T_{jmax}$           |                                                           | 150       | °C               |
| <b>Buck Switch</b>                  |                      |                                                           |           |                  |
| Collector-emitter breakdown voltage | $V_{CE}$             |                                                           | 1200      | V                |
| DC collector current                | $I_C$                | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                     | 156       | A                |
| Repetitive peak collector current   | $I_{CRM}$            | $t_p$ limited by $T_{jmax}$                               | 480       | A                |
| Turn off safe operating area        |                      | $V_{CEmax} = 1200\text{ V}$ , $T_{vj} \leq 150\text{ °C}$ | 320       | A                |
| Power dissipation                   | $P_{tot}$            | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                     | 398       | W                |
| Gate-emitter peak voltage           | $V_{GE}$             |                                                           | ±20       | V                |
| Short circuit ratings               | $t_{SC}$<br>$V_{CC}$ | $T_j \leq 150\text{ °C}$<br>$V_{GE} = 15\text{ V}$        | 10<br>800 | µs<br>V          |
| Maximum Junction Temperature        | $T_{jmax}$           |                                                           | 175       | °C               |



## Maximum Ratings

 $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|-----------|--------|-----------|-------|------|
|-----------|--------|-----------|-------|------|

### Buck Diode

|                                 |            |                                                     |     |                    |
|---------------------------------|------------|-----------------------------------------------------|-----|--------------------|
| Peak Repetitive Reverse Voltage | $V_{RRM}$  |                                                     | 650 | V                  |
| DC forward current              | $I_F$      | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$ | 96  | A                  |
| Power dissipation               | $P_{tot}$  | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$ | 129 | W                  |
| Maximum Junction Temperature    | $T_{Jmax}$ |                                                     | 175 | $^{\circ}\text{C}$ |

### Boost Switch

|                                     |                      |                                                                     |          |                    |
|-------------------------------------|----------------------|---------------------------------------------------------------------|----------|--------------------|
| Collector-emitter breakdown voltage | $V_{CE}$             |                                                                     | 650      | V                  |
| DC collector current                | $I_C$                | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$                 | 94       | A                  |
| Repetitive peak collector current   | $I_{CRM}$            | $t_p$ limited by $T_{Jmax}$                                         | 300      | A                  |
| Turn off safe operating area        |                      | $V_{CE} \leq 600\text{ V}$ , $T_J \leq 175\text{ }^{\circ}\text{C}$ | 300      | A                  |
| Power dissipation                   | $P_{tot}$            | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$                 | 174      | W                  |
| Gate-emitter peak voltage           | $V_{GE}$             |                                                                     | $\pm 20$ | V                  |
| Short circuit ratings               | $t_{SC}$<br>$V_{CC}$ | $T_J \leq 150\text{ }^{\circ}\text{C}$<br>$V_{GE} = 15\text{ V}$    | 6<br>360 | $\mu\text{s}$<br>V |
| Maximum Junction Temperature        | $T_{Jmax}$           |                                                                     | 175      | $^{\circ}\text{C}$ |

### Boost Inverse Diode

|                                    |            |                                                     |     |                    |
|------------------------------------|------------|-----------------------------------------------------|-----|--------------------|
| Peak Repetitive Reverse Voltage    | $V_{RRM}$  |                                                     | 650 | V                  |
| DC forward current                 | $I_F$      | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$ | 38  | A                  |
| Maximum repetitive forward current | $I_{FRM}$  | $t_p$ limited by $T_{Jmax}$                         | 60  | A                  |
| Power dissipation                  | $P_{tot}$  | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$ | 65  | W                  |
| Maximum Junction Temperature       | $T_{Jmax}$ |                                                     | 175 | $^{\circ}\text{C}$ |

### Boost Diode

|                                  |            |                                                     |      |                    |
|----------------------------------|------------|-----------------------------------------------------|------|--------------------|
| Peak Repetitive Reverse Voltage  | $V_{RRM}$  |                                                     | 1200 | V                  |
| DC forward current               | $I_F$      | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$ | 65   | A                  |
| Nonrepetitive peak surge current | $I_{FSM}$  | $t_p = 8,3\text{ ms}$ Half sine wave 60 Hz          | 650  | A                  |
| Power dissipation                | $P_{tot}$  | $T_J = T_{Jmax}$ $T_s = 80\text{ }^{\circ}\text{C}$ | 128  | W                  |
| Maximum Junction Temperature     | $T_{Jmax}$ |                                                     | 175  | $^{\circ}\text{C}$ |

### Thermal Properties

|                                                 |           |  |                            |                    |
|-------------------------------------------------|-----------|--|----------------------------|--------------------|
| Storage temperature                             | $T_{stg}$ |  | $-40\dots+125$             | $^{\circ}\text{C}$ |
| Operation temperature under switching condition | $T_{op}$  |  | $-40\dots+(T_{Jmax} - 25)$ | $^{\circ}\text{C}$ |

### Isolation Properties

|                            |          |                                     |          |    |
|----------------------------|----------|-------------------------------------|----------|----|
| Isolation voltage          | $V_{is}$ | DC Test Voltage* $t_p = 2\text{ s}$ | 4000     | V  |
|                            |          | AC Voltage $t_p = 1\text{ min}$     | 2500     | V  |
| Creepage distance          |          |                                     | min 12,7 | mm |
| Clearance                  |          |                                     | min 12,7 | mm |
| Comparative tracking index | CTI      |                                     | >200     |    |

\* 100 % Tested in production



## Characteristic Values

| Parameter                                     | Symbol               | Conditions                                      |                              |                                           |                                     |            | Value |               |      | Unit |
|-----------------------------------------------|----------------------|-------------------------------------------------|------------------------------|-------------------------------------------|-------------------------------------|------------|-------|---------------|------|------|
|                                               |                      |                                                 | $V_{GE}$ [V]<br>$V_{GS}$ [V] | $V_F$ [V]<br>$V_{CE}$ [V]<br>$V_{DS}$ [V] | $I_C$ [A]<br>$I_F$ [A]<br>$I_D$ [A] | $T_j$ [°C] | Min   | Typ           | Max  |      |
| Buck Inverse Diode                            |                      |                                                 |                              |                                           |                                     |            |       |               |      |      |
| Forward voltage                               | $V_F$                |                                                 |                              |                                           | 7                                   | 25<br>125  | 1     | 1,97<br>1,65  | 3,4  | V    |
| Threshold voltage (for power loss calc. only) | $V_{to}$             |                                                 |                              |                                           | 7                                   | 25<br>125  |       | 1,33<br>1,01  |      | V    |
| Slope resistance (for power loss calc. only)  | $r_t$                |                                                 |                              |                                           | 7                                   | 25<br>125  |       | 91<br>91      |      | mΩ   |
| Reverse current                               | $I_r$                |                                                 |                              | 1200                                      |                                     | 25         |       |               | 0,25 | mA   |
| Thermal resistance junction to sink           | $R_{th(j-s)}$        | phase-change material<br>λ = 3,4 W/mK           |                              |                                           |                                     |            |       | 1,57          |      | K/W  |
| Buck Switch                                   |                      |                                                 |                              |                                           |                                     |            |       |               |      |      |
| Gate emitter threshold voltage                | $V_{GE(th)}$         | $V_{CE} = V_{GE}$                               |                              |                                           | 0,006                               | 25         | 5,3   | 5,8           | 6,3  | V    |
| Collector-emitter saturation voltage          | $V_{CESat}$          |                                                 | 15                           |                                           | 160                                 | 25<br>125  | 2     | 2,02<br>2,37  | 2,42 | V    |
| Collector-emitter cut-off current incl. Diode | $I_{CES}$            |                                                 | 0                            | 1200                                      |                                     | 25         |       |               | 0,02 | mA   |
| Gate-emitter leakage current                  | $I_{GES}$            |                                                 | 20                           | 0                                         |                                     | 25         |       |               | 480  | nA   |
| Integrated Gate resistor                      | $R_{gint}$           |                                                 |                              |                                           |                                     |            |       | none          |      | Ω    |
| Turn-on delay time                            | $t_{d(on)}$          | $R_{goff} = 4\ \Omega$<br>$R_{gon} = 4\ \Omega$ | ±15                          | 350                                       | 150                                 | 25<br>125  |       | 134<br>132    |      | ns   |
| Rise time                                     | $t_r$                |                                                 |                              |                                           |                                     | 25<br>125  |       | 29<br>33      |      |      |
| Turn-off delay time                           | $t_{d(off)}$         |                                                 |                              |                                           |                                     | 25<br>125  |       | 199<br>247    |      |      |
| Fall time                                     | $t_f$                |                                                 |                              |                                           |                                     | 25<br>125  |       | 36<br>54,8    |      |      |
| Turn-on energy loss                           | $E_{on}$             |                                                 |                              |                                           |                                     | 25<br>125  |       | 1,82<br>3,36  |      | mWs  |
| Turn-off energy loss                          | $E_{off}$            |                                                 |                              |                                           |                                     | 25<br>125  |       | 3,39<br>5,81  |      |      |
| Input capacitance                             | $C_{ies}$            | $f = 1\text{ MHz}$                              | 0                            | 25                                        | 25                                  | 25         |       | 9320          |      | pF   |
| Output capacitance                            | $C_{oss}$            |                                                 |                              |                                           |                                     |            |       | 600           |      |      |
| Reverse transfer capacitance                  | $C_{rss}$            |                                                 |                              |                                           |                                     |            |       | 520           |      |      |
| Gate charge                                   | $Q_G$                |                                                 | 15                           | 960                                       | 160                                 |            |       | 740           |      | nC   |
| Thermal resistance junction to sink           | $R_{th(j-s)}$        | phase-change material<br>λ = 3,4 W/mK           |                              |                                           |                                     |            |       | 0,22          |      | K/W  |
| Buck Diode                                    |                      |                                                 |                              |                                           |                                     |            |       |               |      |      |
| Diode forward voltage                         | $V_F$                | $R_{gon} = 4\ \Omega$                           | ±15                          | 350                                       | 150                                 | 25<br>125  |       | 2,28<br>1,67  |      | V    |
| Peak reverse recovery current                 | $I_{RRM}$            |                                                 |                              |                                           |                                     | 25<br>125  |       | 92<br>133     |      | A    |
| Reverse recovery time                         | $t_{rr}$             |                                                 |                              |                                           |                                     | 25<br>125  |       | 30<br>115     |      | ns   |
| Reverse recovered charge                      | $Q_{rr}$             |                                                 |                              |                                           |                                     | 25<br>125  |       | 1,65<br>6,41  |      | μC   |
| Peak rate of fall of recovery current         | $(di_{rr}/dt)_{max}$ |                                                 |                              |                                           |                                     | 25<br>125  |       | 12559<br>4726 |      | A/μs |
| Reverse recovered energy                      | $E_{rec}$            |                                                 |                              |                                           |                                     | 25<br>125  |       | 0,23<br>1,25  |      | mWs  |
| Thermal resistance junction to sink           | $R_{th(j-s)}$        | phase-change material<br>λ = 3,4 W/mK           |                              |                                           |                                     |            |       | 0,73          |      | K/W  |



## Characteristic Values

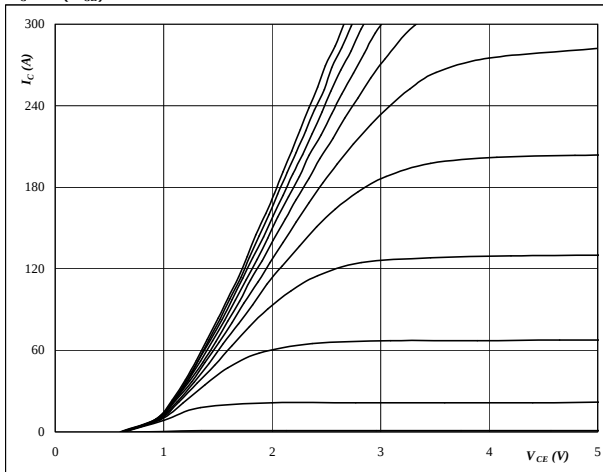
| Parameter                             | Symbol               | Conditions                                      |                              |                                           |                                     |            | Value |              |        | Unit |
|---------------------------------------|----------------------|-------------------------------------------------|------------------------------|-------------------------------------------|-------------------------------------|------------|-------|--------------|--------|------|
|                                       |                      |                                                 | $V_{GE}$ [V]<br>$V_{GS}$ [V] | $V_F$ [V]<br>$V_{CE}$ [V]<br>$V_{DS}$ [V] | $I_C$ [A]<br>$I_F$ [A]<br>$I_D$ [A] | $T_J$ [°C] | Min   | Typ          | Max    |      |
| Boost Switch                          |                      |                                                 |                              |                                           |                                     |            |       |              |        |      |
| Gate emitter threshold voltage        | $V_{GE(th)}$         | $V_{CE} = V_{GE}$                               |                              |                                           | 0,0016                              | 25         | 5,1   | 5,8          | 6,4    | V    |
| Collector-emitter saturation voltage  | $V_{CEsat}$          |                                                 | 15                           |                                           | 100                                 | 25<br>125  | 0,93  | 1,58<br>1,8  | 1,77   | V    |
| Collector-emitter cut-off incl diode  | $I_{CES}$            |                                                 | 0                            | 650                                       |                                     | 25         |       |              | 0,0056 | mA   |
| Gate-emitter leakage current          | $I_{GES}$            |                                                 | 20                           | 0                                         |                                     | 25         |       |              | 300    | nA   |
| Integrated Gate resistor              | $R_{gint}$           |                                                 |                              |                                           |                                     |            |       | none         |        | Ω    |
| Turn-on delay time                    | $t_{d(on)}$          | $R_{gon} = 4\ \Omega$<br>$R_{goff} = 4\ \Omega$ | ±15                          | 350                                       | 100                                 | 25<br>125  |       | 103<br>103   |        | ns   |
| Rise time                             | $t_r$                |                                                 |                              |                                           |                                     | 25<br>125  |       | 17<br>19     |        |      |
| Turn-off delay time                   | $t_{d(off)}$         |                                                 |                              |                                           |                                     | 25<br>125  |       | 158<br>179   |        |      |
| Fall time                             | $t_f$                |                                                 |                              |                                           |                                     | 25<br>125  |       | 44<br>64     |        |      |
| Turn-on energy loss                   | $E_{on}$             |                                                 |                              |                                           |                                     | 25<br>125  |       | 1,06<br>1,52 |        | μWs  |
| Turn-off energy loss                  | $E_{off}$            |                                                 |                              |                                           |                                     | 25<br>125  |       | 2,48<br>3,32 |        |      |
| Input capacitance                     | $C_{ies}$            | $f = 1\ \text{MHz}$                             | 0                            | 25                                        | 25                                  |            |       | 6280         |        | pF   |
| Output capacitance                    | $C_{oss}$            |                                                 |                              |                                           |                                     |            |       | 400          |        |      |
| Reverse transfer capacitance          | $C_{rss}$            |                                                 |                              |                                           |                                     |            |       | 186          |        |      |
| Gate charge                           | $Q_G$                |                                                 | 15                           | 480                                       | 100                                 |            |       | 620          |        | nC   |
| Thermal resistance junction to sink   | $R_{th(j-s)}$        | phase-change material<br>λ = 3,4 W/mK           |                              |                                           |                                     |            |       | 0,48         |        | K/W  |
| Boost Inverse Diode                   |                      |                                                 |                              |                                           |                                     |            |       |              |        |      |
| Diode forward voltage                 | $V_F$                | phase-change material                           |                              |                                           | 30                                  | 25<br>125  | 1,23  | 1,64<br>1,55 | 1,87   | V    |
| Thermal resistance junction to sink   | $R_{th(j-s)}$        | λ = 3,4 W/mK                                    |                              |                                           |                                     |            |       | 1,22         |        | K/W  |
| Boost Diode                           |                      |                                                 |                              |                                           |                                     |            |       |              |        |      |
| Diode forward voltage                 | $V_F$                |                                                 |                              |                                           | 60                                  | 25<br>150  | 1,50  | 2,47<br>2,11 | 3,30   | V    |
| Reverse leakage current               | $I_r$                |                                                 |                              | 1200                                      |                                     | 25         |       |              | 200    | μA   |
| Peak reverse recovery current         | $I_{RRM}$            | $R_{gon} = 4\ \Omega$                           | ±15                          | 350                                       | 100                                 | 25<br>150  |       | 107<br>142   |        | A    |
| Reverse recovery time                 | $t_{rr}$             |                                                 |                              |                                           |                                     | 25<br>150  |       | 51<br>69     |        | ns   |
| Reverse recovered charge              | $Q_{rr}$             |                                                 |                              |                                           |                                     | 25<br>150  |       | 6<br>13      |        | μC   |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ |                                                 |                              |                                           |                                     | 25<br>150  |       | 5985<br>2890 |        | A/μs |
| Reverse recovery energy               | $E_{rec}$            |                                                 |                              |                                           |                                     | 25<br>150  |       | 1,71<br>3,61 |        | mWs  |
| Thermal resistance junction to sink   | $R_{th(j-s)}$        | phase-change material<br>λ = 3,4 W/mK           |                              |                                           |                                     |            |       | 0,68         |        | K/W  |
| Thermistor                            |                      |                                                 |                              |                                           |                                     |            |       |              |        |      |
| Rated resistance                      | $R$                  |                                                 |                              |                                           |                                     | 25         |       | 22000        |        | Ω    |
| Deviation of $R_{100}$                | $\Delta_{R/R}$       | $R_{100} = 1486\ \Omega$                        |                              |                                           |                                     | 100        | -12   |              | +12    | %    |
| Power dissipation                     | $P$                  |                                                 |                              |                                           |                                     | 25         |       | 200          |        | mW   |
| Power dissipation constant            |                      |                                                 |                              |                                           |                                     | 25         |       | 2            |        | mW/K |
| B-value                               | $B_{(25/50)}$        | Tol. ±3%                                        |                              |                                           |                                     | 25         |       | 3950         |        | K    |
| B-value                               | $B_{(25/100)}$       | Tol. ±3%                                        |                              |                                           |                                     | 25         |       | 3998         |        | K    |
| Vincotech NTC Reference               |                      |                                                 |                              |                                           |                                     |            |       |              | B      |      |



## Buck Characteristics

**figure 1. IGBT****Typical output characteristics**

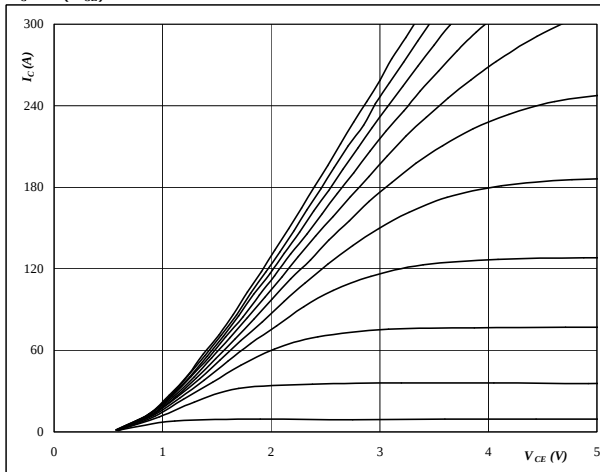
$$I_C = f(V_{CE})$$

**At**

$t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 2. IGBT****Typical output characteristics**

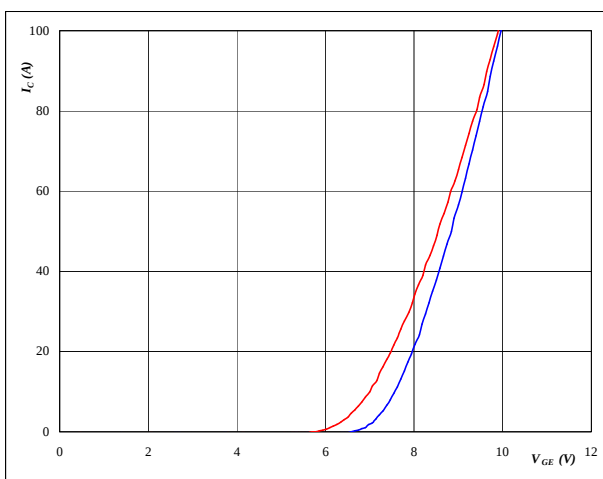
$$I_C = f(V_{CE})$$

**At**

$t_p = 250 \mu s$   
 $T_j = 125 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3. IGBT****Typical transfer characteristics**

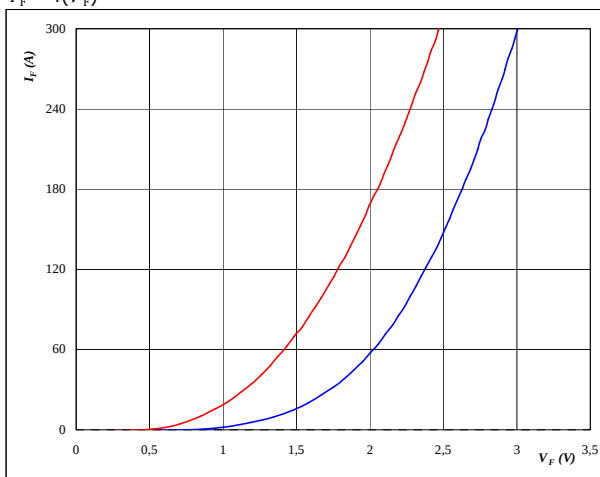
$$I_C = f(V_{GE})$$

**At**

$T_j = 25/125 \text{ } ^\circ C$   
 $t_p = 250 \mu s$   
 $V_{CE} = 10 \text{ V}$   
 $T_j = 25/125 \text{ } ^\circ C$

**figure 4. FWD****Typical FWD forward current as a function of forward voltage**

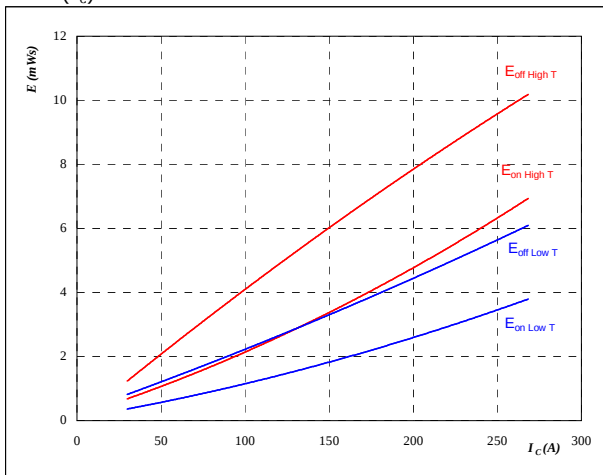
$$I_F = f(V_F)$$

**At**

$T_j = 25/125 \text{ } ^\circ C$   
 $t_p = 250 \mu s$

**Buck Characteristics****figure 5.****IGBT****Typical switching energy losses  
as a function of collector current**

$$E = f(I_C)$$



With an inductive load at

$T_j = 25/125\ ^\circ\text{C}$

$V_{CE} = 350\ \text{V}$

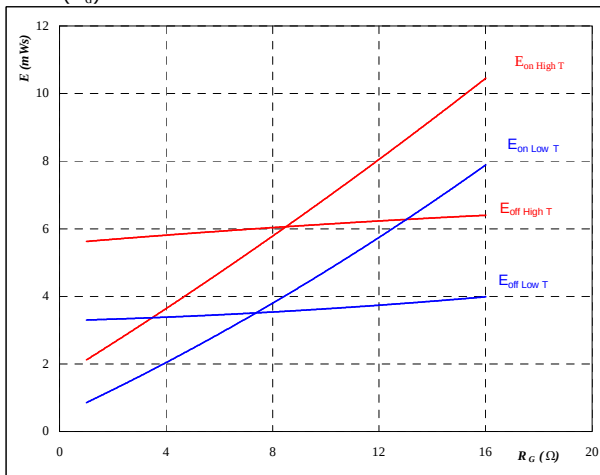
$V_{GE} = \pm 15\ \text{V}$

$R_{gon} = 4\ \Omega$

$R_{goff} = 4\ \Omega$

**figure 6.****IGBT****Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$T_j = 25/125\ ^\circ\text{C}$

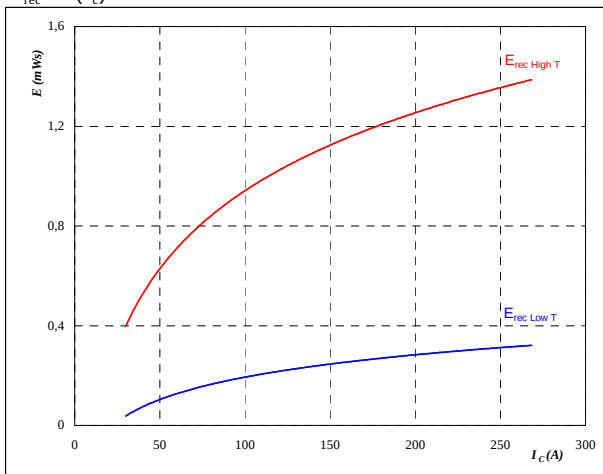
$V_{CE} = 350\ \text{V}$

$V_{GE} = \pm 15\ \text{V}$

$I_C = 150\ \text{A}$

**figure 7.****FWD****Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_C)$$



With an inductive load at

$T_j = 25/125\ ^\circ\text{C}$

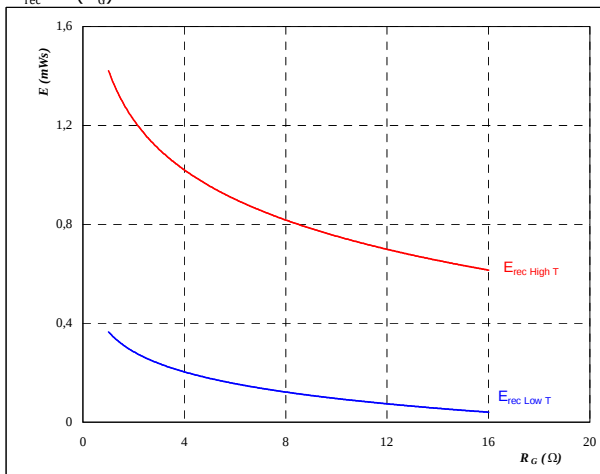
$V_{CE} = 350\ \text{V}$

$V_{GE} = \pm 15\ \text{V}$

$R_{gon} = 4\ \Omega$

**figure 8.****FWD****Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$T_j = 25/125\ ^\circ\text{C}$

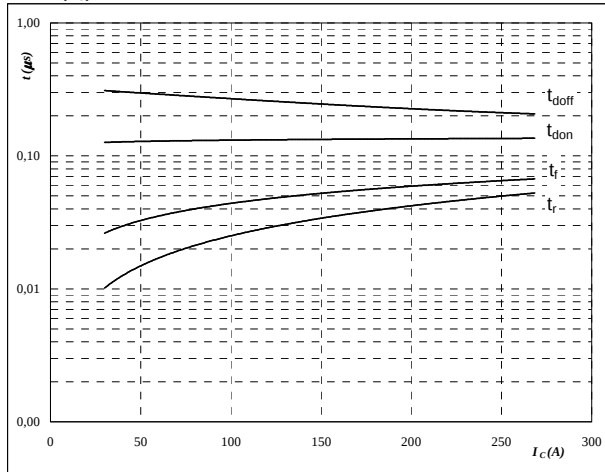
$V_{CE} = 350\ \text{V}$

$V_{GE} = \pm 15\ \text{V}$

$I_C = 150\ \text{A}$

**Buck Characteristics****figure 9. IGBT****Typical switching times as a function of collector current**

$$t = f(I_C)$$



With an inductive load at

$$T_j = 125 \text{ } ^\circ\text{C}$$

$$V_{CE} = 350 \text{ V}$$

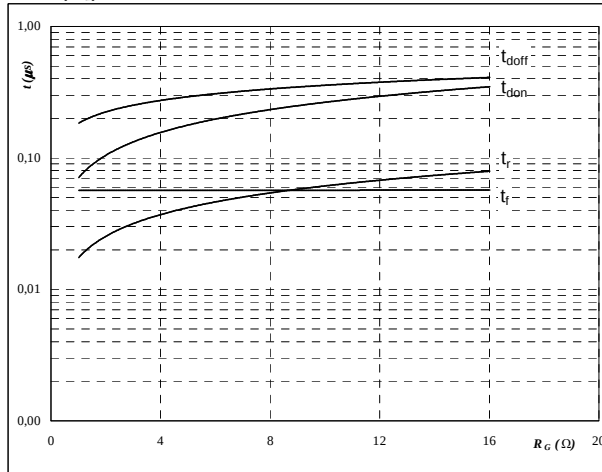
$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

$$R_{goff} = 4 \text{ } \Omega$$

**figure 10. IGBT****Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



With an inductive load at

$$T_j = 125 \text{ } ^\circ\text{C}$$

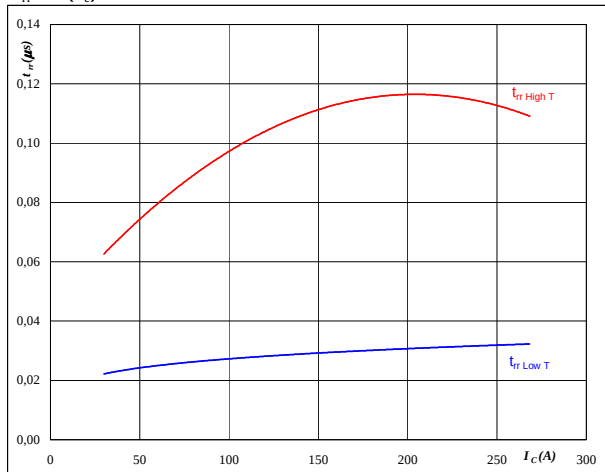
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$I_C = 150 \text{ A}$$

**figure 11. FWD****Typical reverse recovery time as a function of collector current**

$$t_{rr} = f(I_C)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

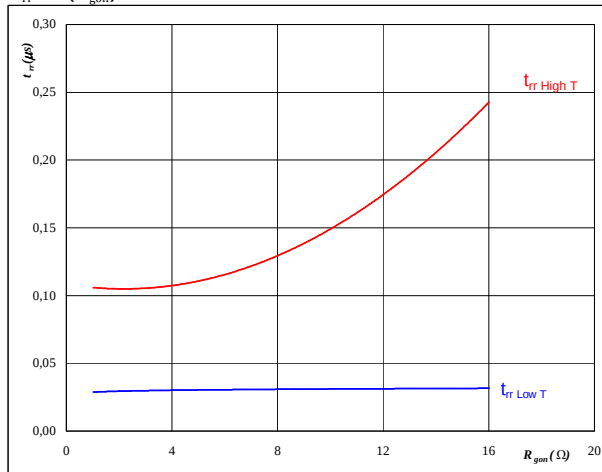
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 12. FWD****Typical reverse recovery time as a function of IGBT turn on gate resistor**

$$t_{rr} = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

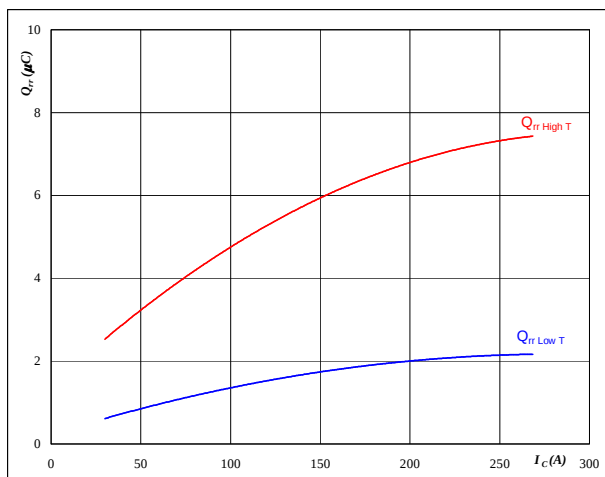
$$V_R = 350 \text{ V}$$

$$I_F = 150 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**Buck Characteristics****figure 13.** FWD**Typical reverse recovery charge as a function of collector current**

$$Q_{rr} = f(I_C)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

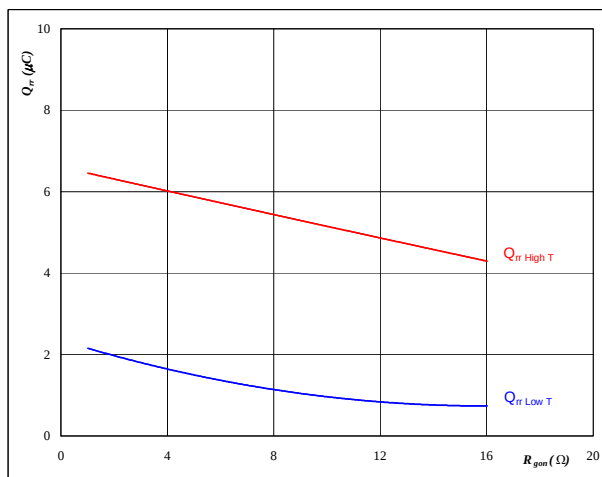
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 14.** FWD**Typical reverse recovery charge as a function of IGBT turn on gate resistor**

$$Q_{rr} = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

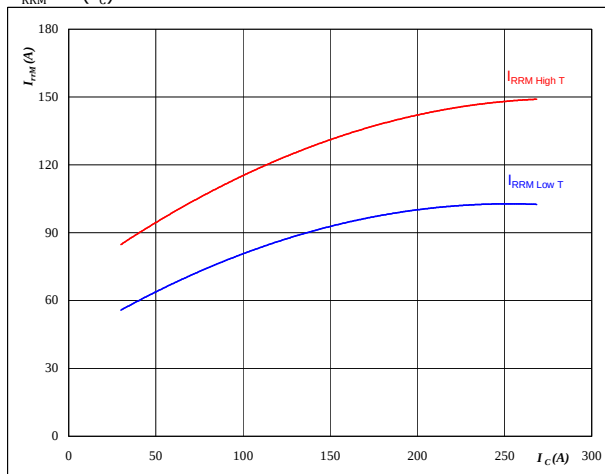
$$V_R = 350 \text{ V}$$

$$I_F = 150 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**figure 15.** FWD**Typical reverse recovery current as a function of collector current**

$$I_{RRM} = f(I_C)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

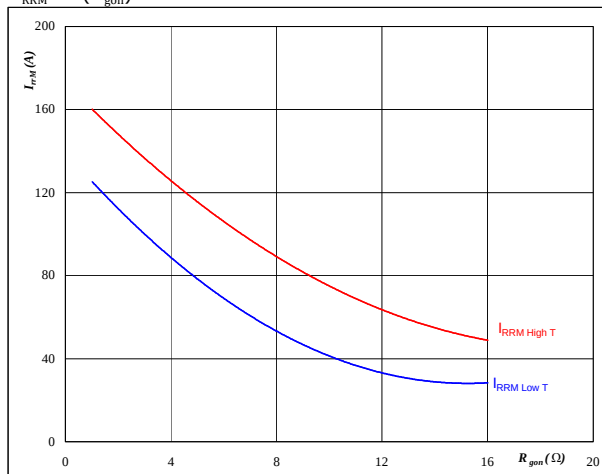
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 16.** FWD**Typical reverse recovery current as a function of IGBT turn on gate resistor**

$$I_{RRM} = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

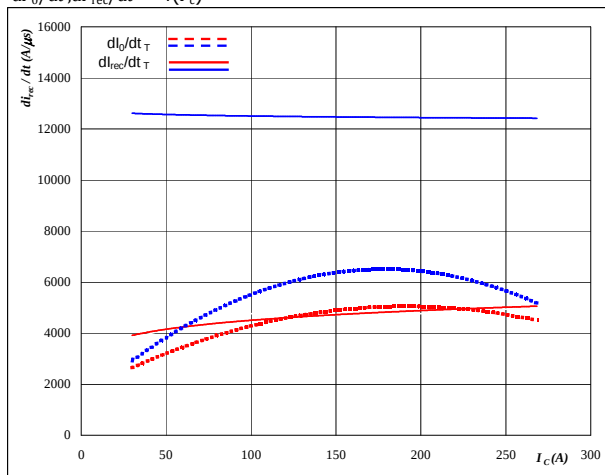
$$V_R = 350 \text{ V}$$

$$I_F = 150 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**Buck Characteristics****figure 17.** FWD**Typical rate of fall of forward and reverse recovery current as a function of collector current**

$$dI_0/dt, dI_{rec}/dt = f(I_c)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

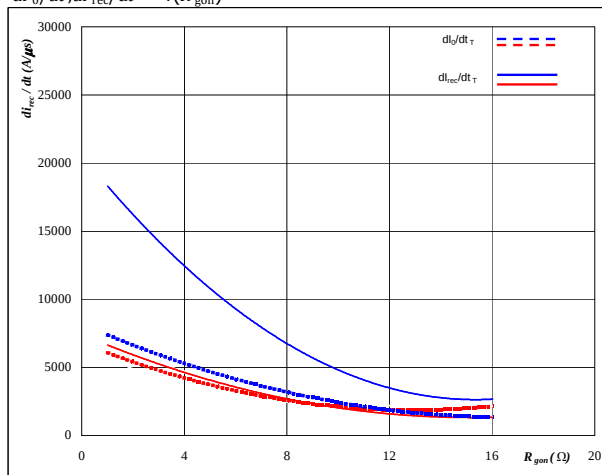
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 18.** FWD**Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor**

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

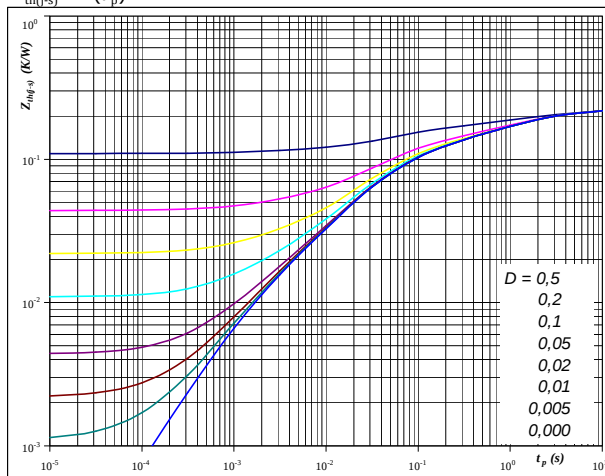
$$V_R = 350 \text{ V}$$

$$I_F = 150 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**figure 19.** IGBT**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

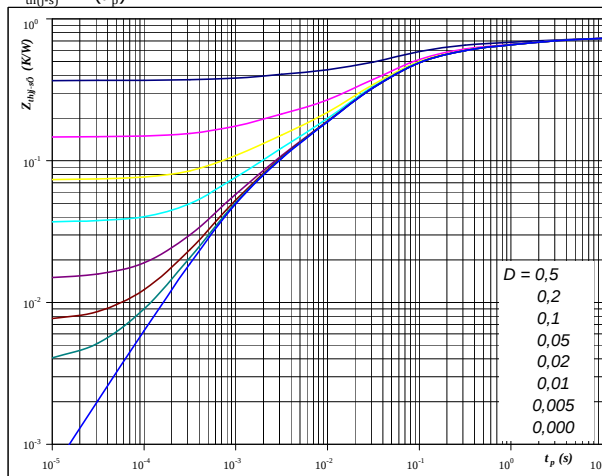
$$R_{th(j-s)} = 0,22 \text{ K/W}$$

IGBT thermal model values

| R (K/W) | Tau (s) |
|---------|---------|
| 8,1E-02 | 2,3E+00 |
| 5,7E-02 | 2,9E-01 |
| 7,2E-02 | 4,6E-02 |
| 2,1E-02 | 1,3E-02 |
| 8,0E-03 | 1,5E-03 |

**figure 20.** FWD**FWD transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 0,73 \text{ K/W}$$

FWD thermal model values

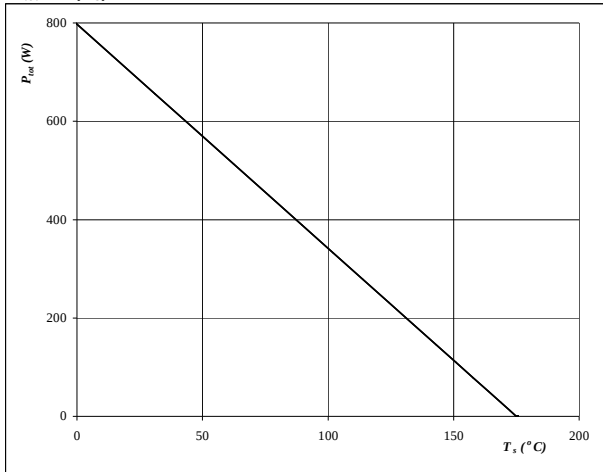
| R (K/W) | Tau (s) |
|---------|---------|
| 6,7E-02 | 4,1E+00 |
| 7,9E-02 | 9,3E-01 |
| 1,9E-01 | 1,4E-01 |
| 2,8E-01 | 3,5E-02 |
| 6,1E-02 | 6,8E-03 |
| 5,6E-02 | 1,2E-03 |



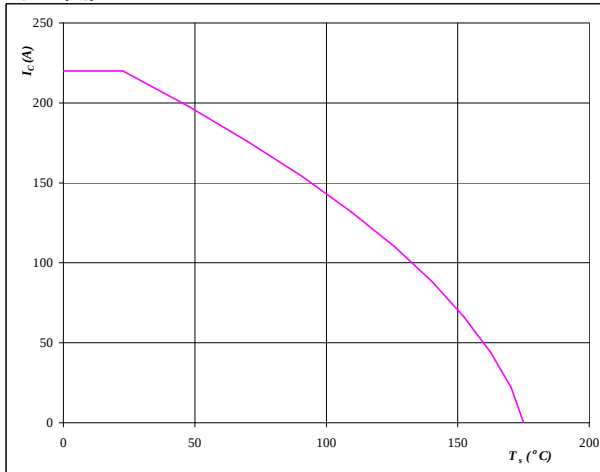
## Buck Characteristics

**figure 21.****IGBT****Power dissipation as a  
function of heatsink temperature**

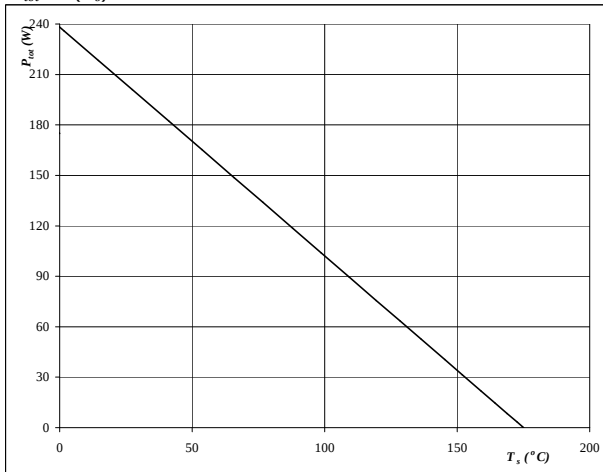
$$P_{\text{tot}} = f(T_s)$$

**At** $T_j = 175$  °C**figure 22.****IGBT****Collector current as a  
function of heatsink temperature**

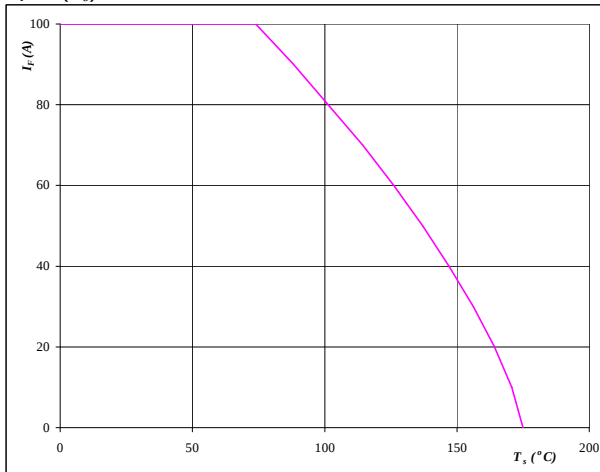
$$I_C = f(T_s)$$

**At** $T_j = 175$  °C $V_{GE} = 15$  V**figure 23.****FWD****Power dissipation as a  
function of heatsink temperature**

$$P_{\text{tot}} = f(T_s)$$

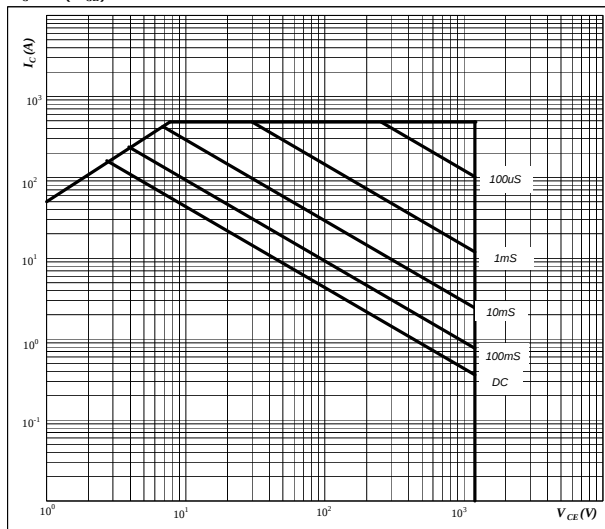
**At** $T_j = 175$  °C**figure 24.****FWD****Forward current as a  
function of heatsink temperature**

$$I_F = f(T_s)$$

**At** $T_j = 175$  °C

**Buck Characteristics****figure 25.****IGBT****Safe operating area as a function  
of collector-emitter voltage**

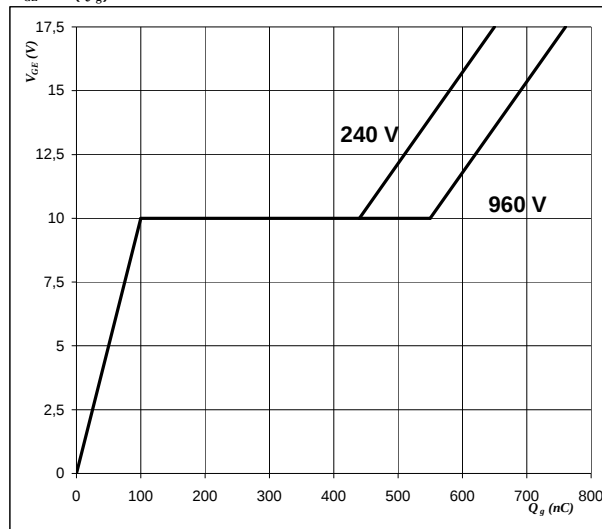
$$I_C = f(V_{CE})$$

**At**

$D =$  single pulse  
 $T_s =$  80 °C  
 $V_{GE} =$   $\pm 15$  V  
 $T_j =$   $T_{jmax}$

**figure 26.****IGBT****Gate voltage vs Gate charge**

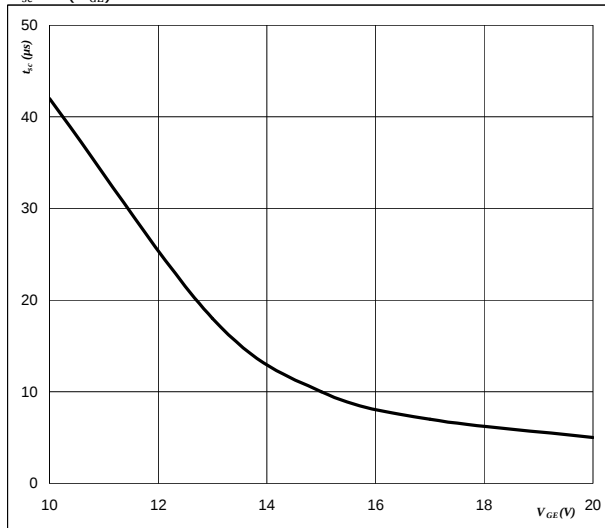
$$V_{GE} = f(Q_g)$$

**At**

$I_C =$  160 A  
 $T_j =$  25 °C

**figure 27.****IGBT****Short circuit withstand time as a function of  
gate-emitter voltage**

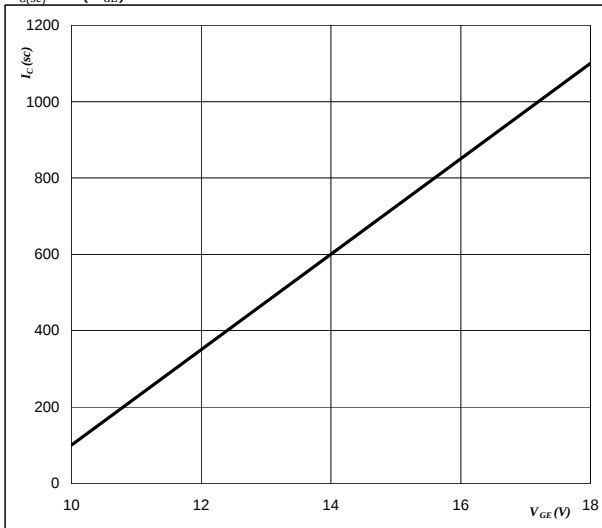
$$t_{sc} = f(V_{GE})$$

**At**

$V_{CE} =$  600 V  
 $T_j \leq$  175 °C

**figure 28.****IGBT****Typical short circuit collector current as a function of  
gate-emitter voltage**

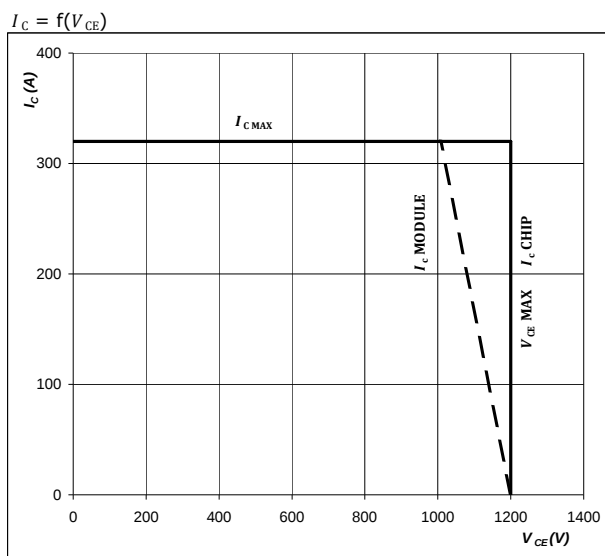
$$I_{C(sc)} = f(V_{GE})$$

**At**

$V_{CE} \leq$  600 V  
 $T_j =$  175 °C



## Buck Characteristics

**figure 29.****IGBT****Reverse bias safe operating area****At**

$$T_j = T_{j\text{max}} - 25 \text{ } ^\circ\text{C}$$

$$V_{\text{ccminus}} = V_{\text{ccplus}}$$

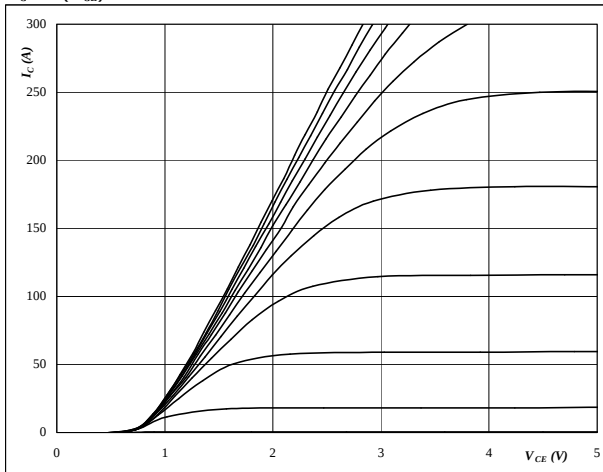
Switching mode : 3 level switching



## Boost Characteristics

**figure 1. IGBT****Typical output characteristics**

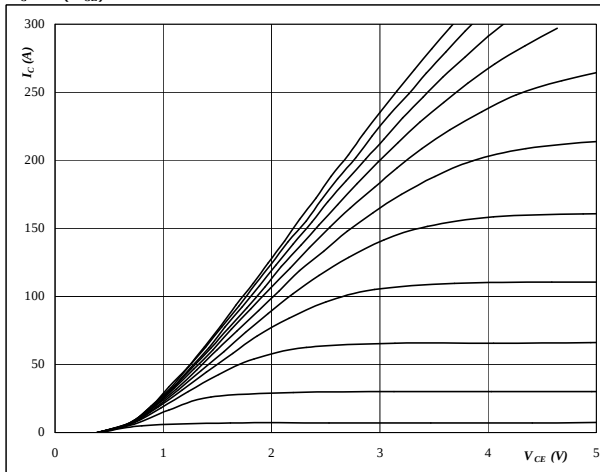
$$I_C = f(V_{CE})$$

**At**

$t_p = 250 \mu s$   
 $T_j = 25 ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 2. IGBT****Typical output characteristics**

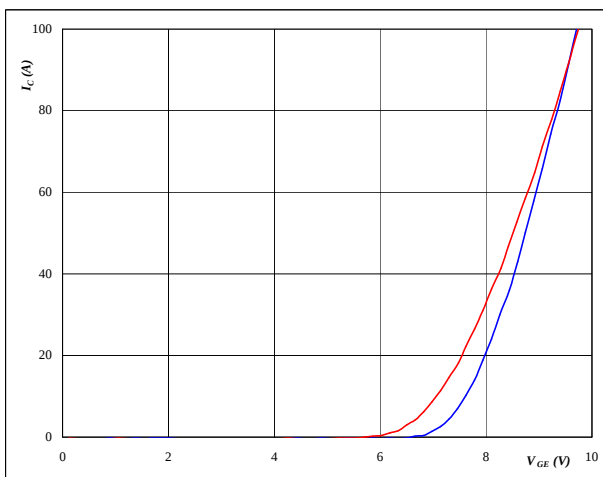
$$I_C = f(V_{CE})$$

**At**

$t_p = 250 \mu s$   
 $T_j = 150 ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3. IGBT****Typical transfer characteristics**

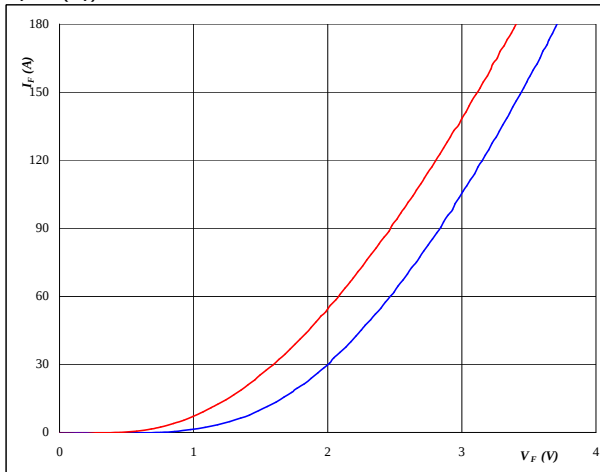
$$I_C = f(V_{GE})$$

**At**

$T_j = 25/150 ^\circ C$   
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**figure 4. FWD****Typical FWD forward current as a function of forward voltage**

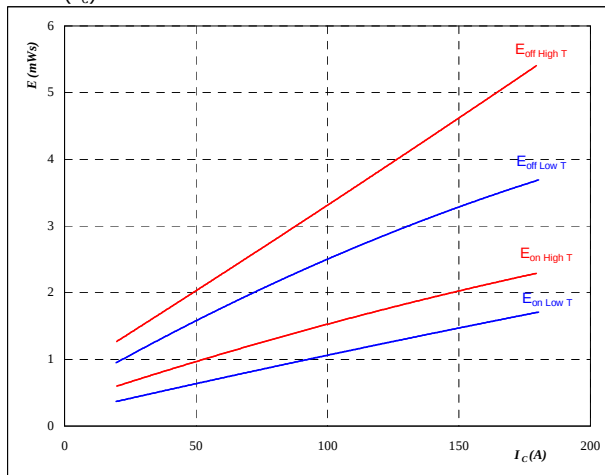
$$I_F = f(V_F)$$

**At**

$T_j = 25/150 ^\circ C$   
 $t_p = 250 \mu s$

**Boost Characteristics****figure 5. IGBT****Typical switching energy losses  
as a function of collector current**

$$E = f(I_C)$$



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$

$V_{CE} = 350 \text{ V}$

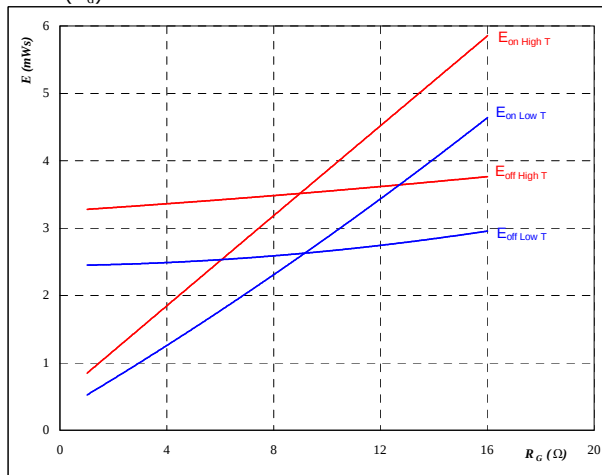
$V_{GE} = \pm 15 \text{ V}$

$R_{gon} = 4 \text{ } \Omega$

$R_{goff} = 4 \text{ } \Omega$

**figure 6. IGBT****Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$

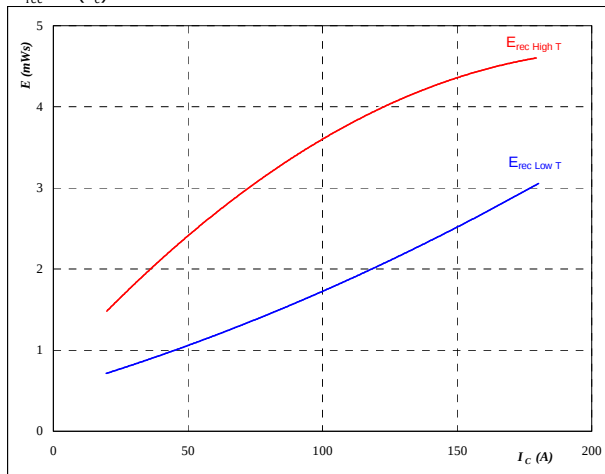
$V_{CE} = 350 \text{ V}$

$V_{GE} = \pm 15 \text{ V}$

$I_C = 100 \text{ A}$

**figure 7. FWD****Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_C)$$



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$

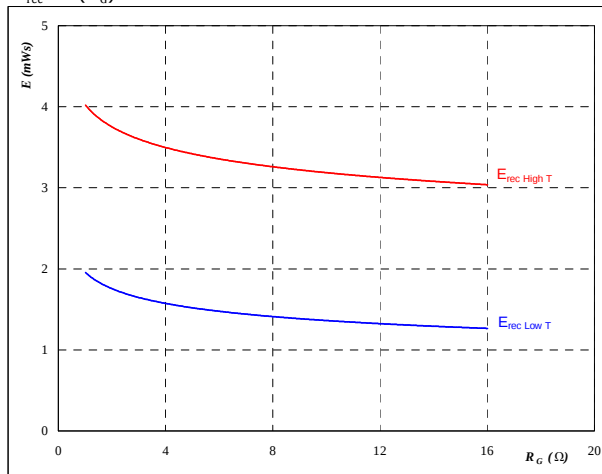
$V_{CE} = 350 \text{ V}$

$V_{GE} = \pm 15 \text{ V}$

$R_{gon} = 4 \text{ } \Omega$

**figure 8. FWD****Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$T_j = 25/125 \text{ } ^\circ\text{C}$

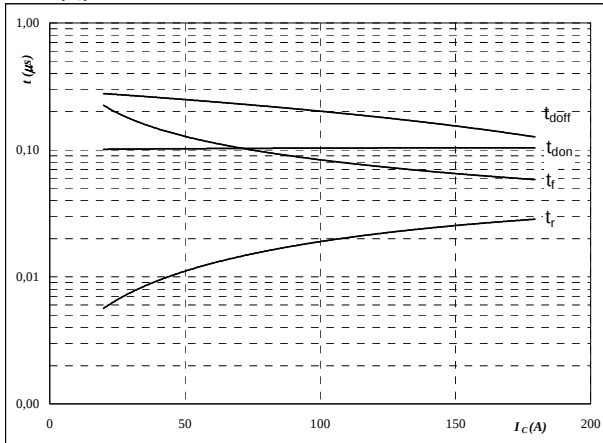
$V_{CE} = 350 \text{ V}$

$V_{GE} = \pm 15 \text{ V}$

$I_C = 100 \text{ A}$

**Boost Characteristics****figure 9.****IGBT****Typical switching times as a function of collector current**

$$t = f(I_C)$$



With an inductive load at

$$T_j = 125 \text{ } ^\circ\text{C}$$

$$V_{CE} = 350 \text{ V}$$

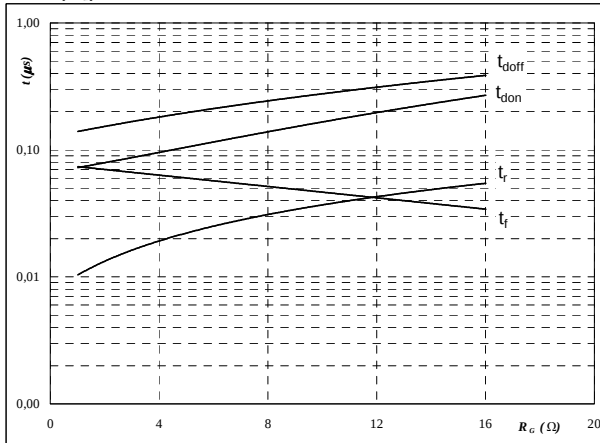
$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

$$R_{goff} = 4 \text{ } \Omega$$

**figure 10.****IGBT****Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



With an inductive load at

$$T_j = 125 \text{ } ^\circ\text{C}$$

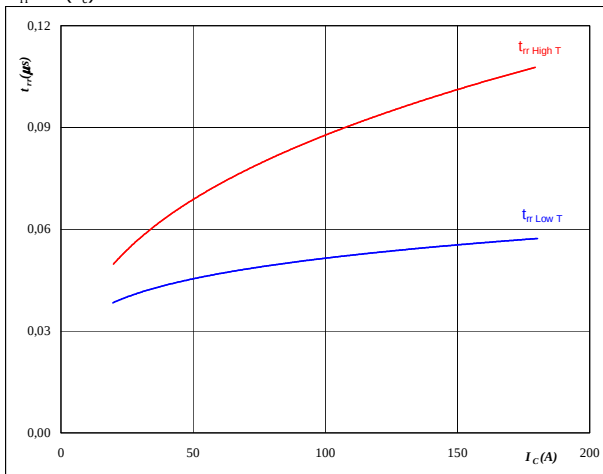
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$I_C = 100 \text{ A}$$

**figure 11.****FWD****Typical reverse recovery time as a function of collector current**

$$t_{rr} = f(I_C)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

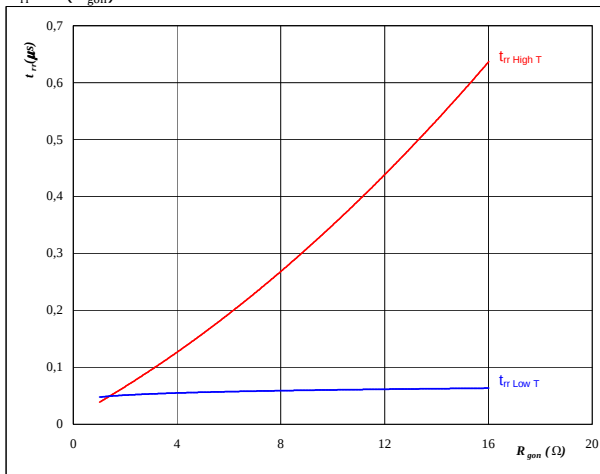
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 12.****FWD****Typical reverse recovery time as a function of IGBT turn on gate resistor**

$$t_{rr} = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

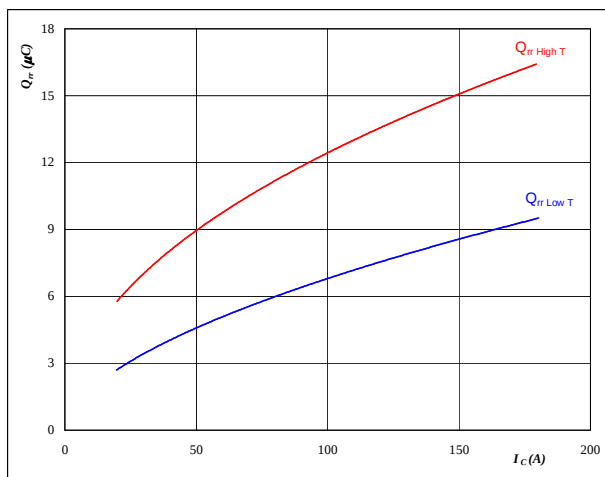
$$V_R = 350 \text{ V}$$

$$I_F = 100 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**Boost Characteristics****figure 13.****FWD****Typical reverse recovery charge as a function of collector current**

$$Q_{rr} = f(I_C)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

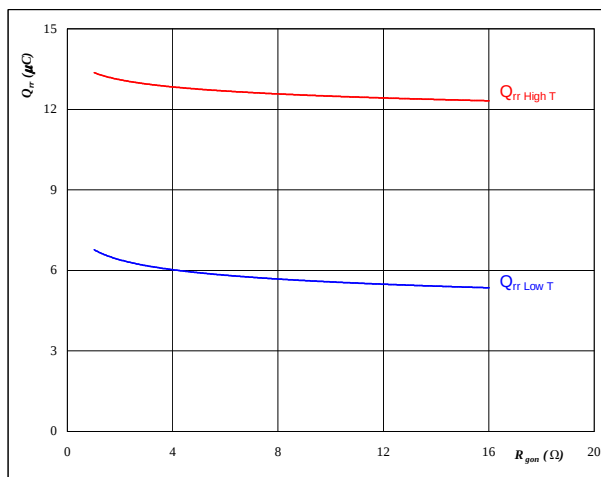
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 14.****FWD****Typical reverse recovery charge as a function of IGBT turn on gate resistor**

$$Q_{rr} = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

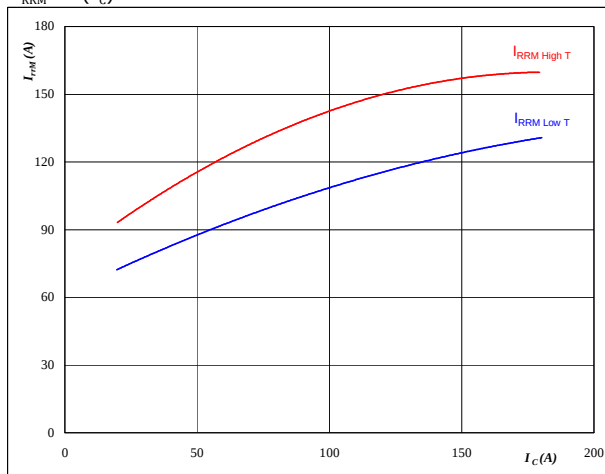
$$V_R = 350 \text{ V}$$

$$I_F = 100 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**figure 15.****FWD****Typical reverse recovery current as a function of collector current**

$$I_{RRM} = f(I_C)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

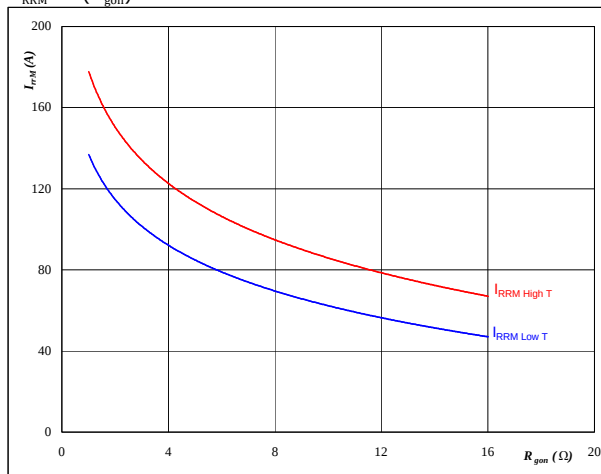
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 16.****FWD****Typical reverse recovery current as a function of IGBT turn on gate resistor**

$$I_{RRM} = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

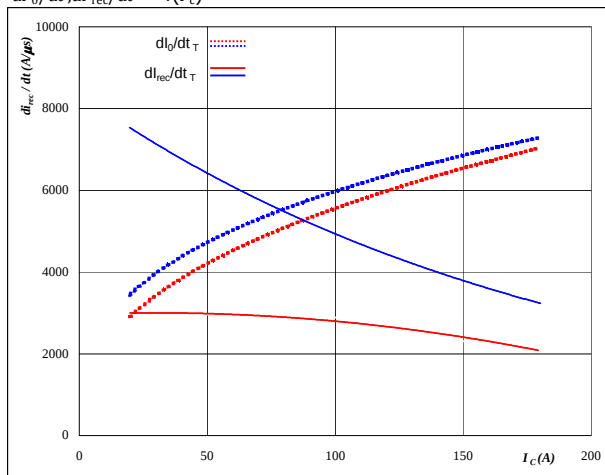
$$V_R = 350 \text{ V}$$

$$I_F = 100 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**Boost Characteristics****figure 17.** FWD**Typical rate of fall of forward and reverse recovery current as a function of collector current**

$$dI_0/dt, dI_{rec}/dt = f(I_c)$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

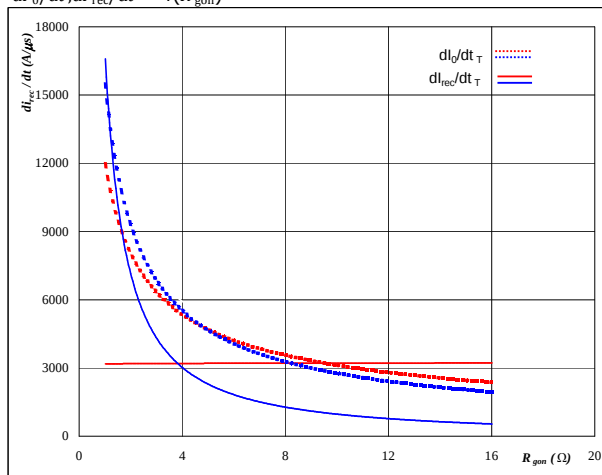
$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 18.** FWD**Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor**

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

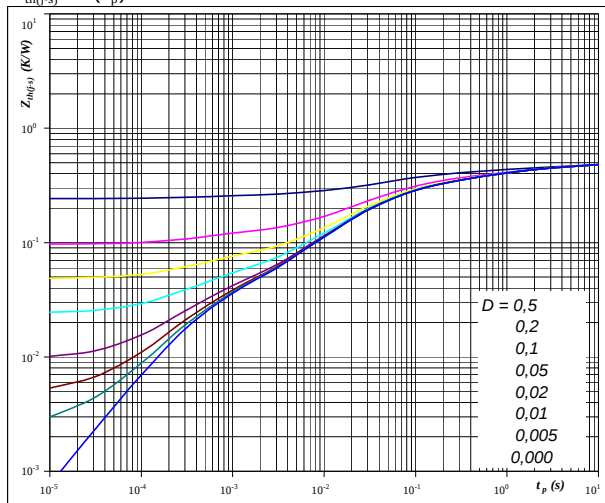
$$V_R = 350 \text{ V}$$

$$I_F = 100 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$

**figure 19.** IGBT**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

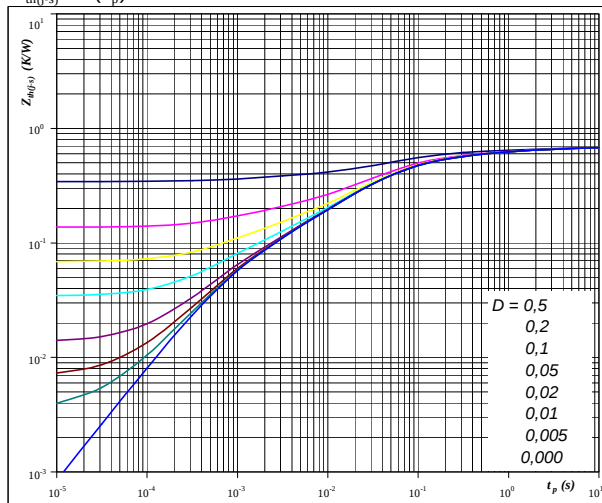
$$R_{th(j-s)} = 0,48 \text{ K/W}$$

IGBT thermal model values

| R (K/W) | Tau (s) |
|---------|---------|
| 1,1E-01 | 2,9E+00 |
| 8,8E-02 | 4,6E-01 |
| 1,2E-01 | 9,5E-02 |
| 1,7E-01 | 2,5E-02 |
| 3,0E-02 | 4,4E-03 |

**figure 20.** FWD**FWD transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 0,68 \text{ K/W}$$

FWD thermal model values

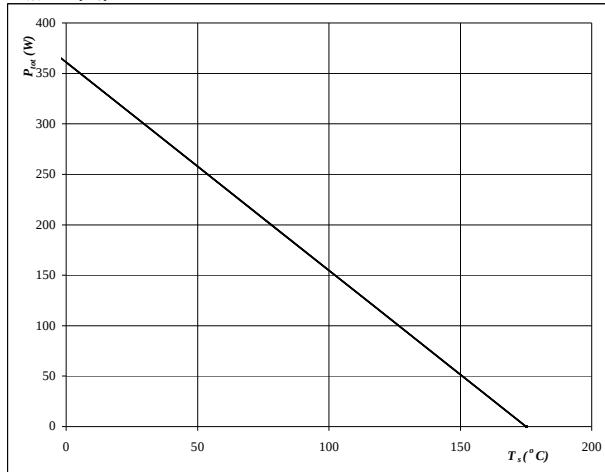
| R (K/W) | Tau (s) |
|---------|---------|
| 6,8E-02 | 3,7E+00 |
| 1,0E-01 | 5,4E-01 |
| 2,0E-01 | 9,8E-02 |
| 2,6E-01 | 2,8E-02 |
| 6,8E-02 | 4,9E-03 |



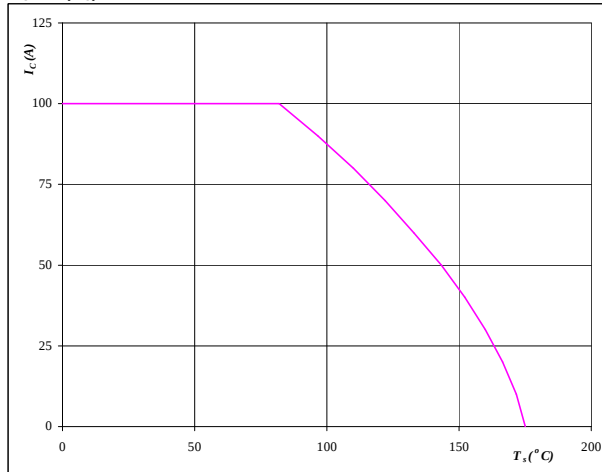
## Boost Characteristics

**figure 21.****IGBT****Power dissipation as a  
function of heatsink temperature**

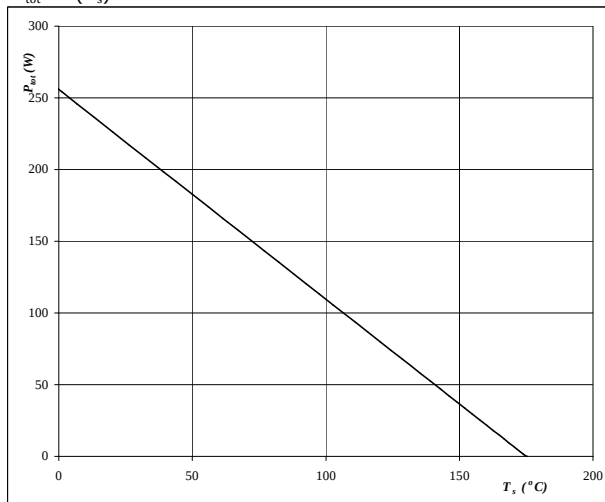
$$P_{\text{tot}} = f(T_s)$$

**At** $T_j = 175$  °C**figure 22.****IGBT****Collector current as a  
function of heatsink temperature**

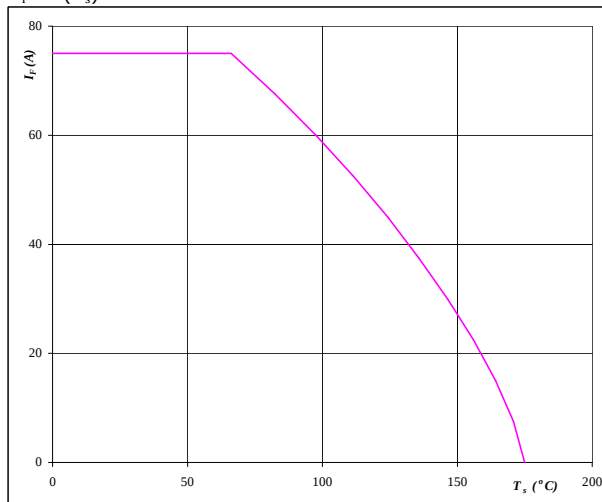
$$I_C = f(T_s)$$

**At** $T_j = 175$  °C $V_{GE} = 15$  V**figure 23.****FWD****Power dissipation as a  
function of heatsink temperature**

$$P_{\text{tot}} = f(T_s)$$

**At** $T_j = 175$  °C**figure 24.****FWD****Forward current as a  
function of heatsink temperature**

$$I_F = f(T_s)$$

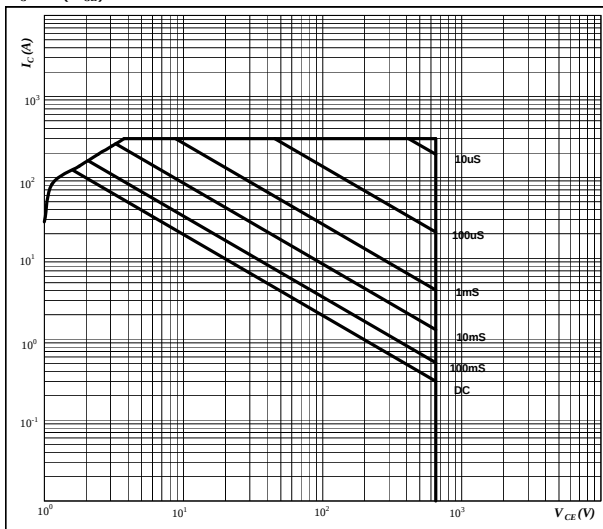
**At** $T_j = 175$  °C



## Boost Characteristics

**figure 25.****IGBT****Safe operating area as a function  
of collector-emitter voltage**

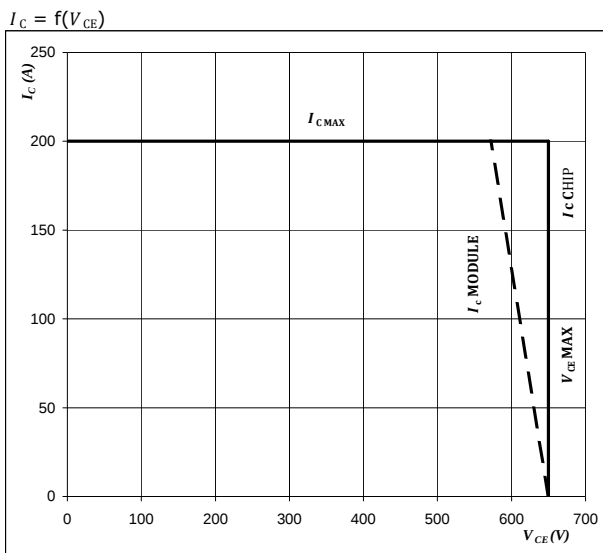
$$I_C = f(V_{CE})$$

**At**

$D =$  single pulse  
 $T_s =$  80 °C  
 $V_{GE} =$  ±15 V  
 $T_j = T_{jmax}$



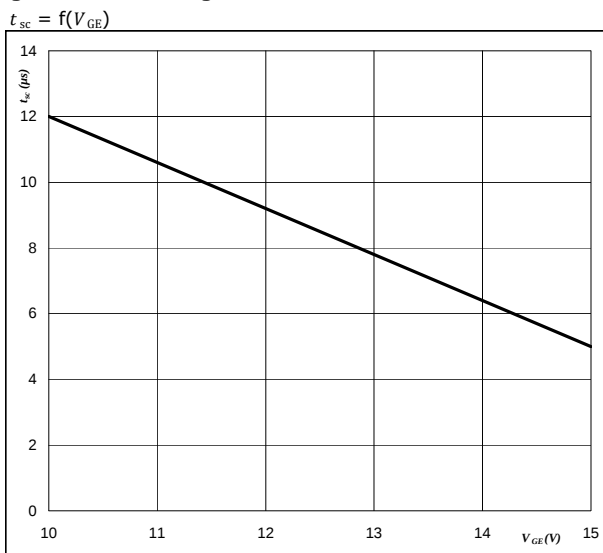
## Boost Characteristics

**figure 25.****IGBT****Reverse bias safe operating area****At**

$$T_j = T_{jmax} - 25 \text{ } ^\circ\text{C}$$

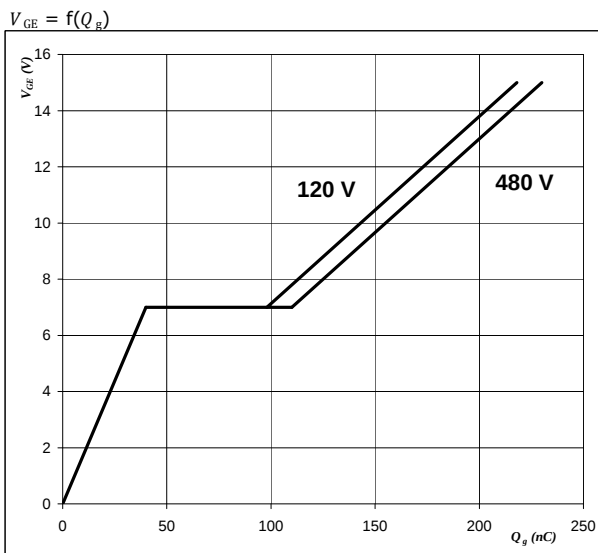
$$V_{cminus} = V_{cplus}$$

Switching mode : 3 level switching

**figure 27.****IGBT****Short circuit withstand time as a function of gate-emitter voltage****At**

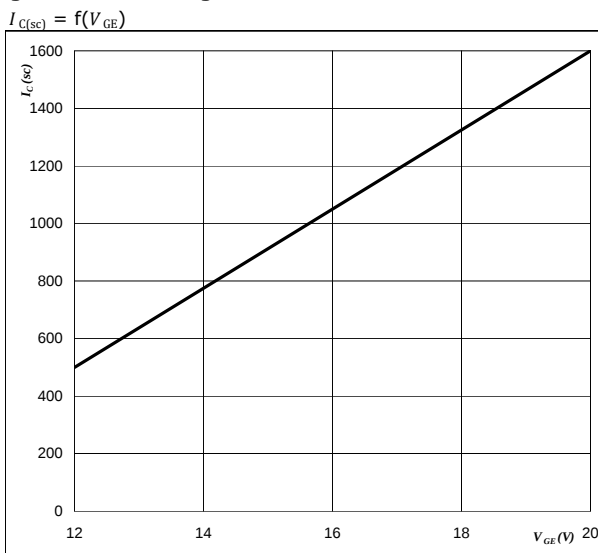
$$V_{CE} = 600 \text{ V}$$

$$T_j \leq 150 \text{ } ^\circ\text{C}$$

**figure 26.****IGBT****Gate voltage vs Gate charge****At**

$$I_C = 100 \text{ A}$$

$$T_j = 25 \text{ } ^\circ\text{C}$$

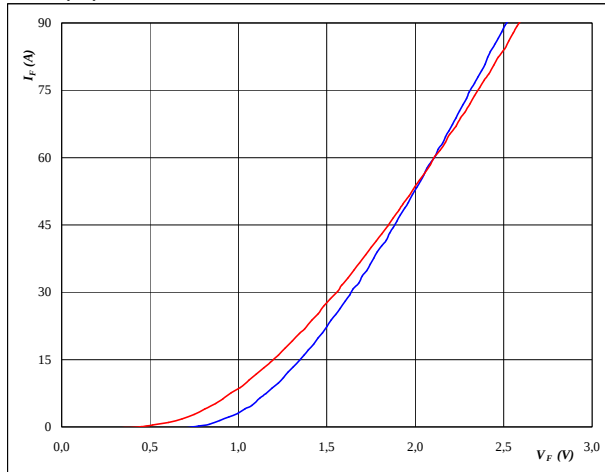
**figure 28.****IGBT****Typical short circuit collector current as a function of gate-emitter voltage****At**

$$V_{CE} \leq 400 \text{ V}$$

$$T_j = 125 \text{ } ^\circ\text{C}$$

**Boost Inverse Diode****figure 25.** FWD**Typical FWD forward current as a function of forward voltage**

$$I_F = f(V_F)$$

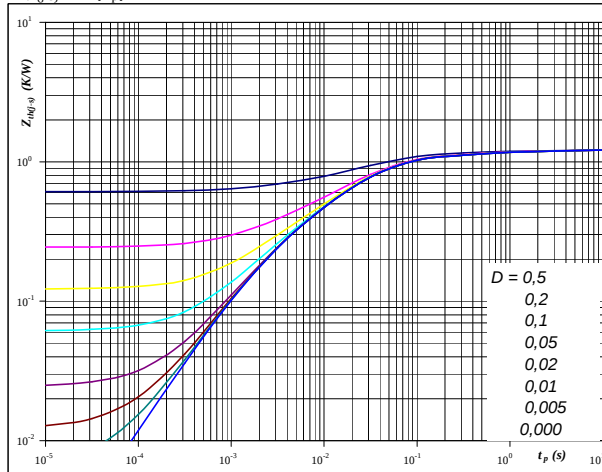
**At**

$$T_j = 25/150 \text{ } ^\circ\text{C}$$

$$t_p = 250 \text{ } \mu\text{s}$$

**figure 26.** FWD**FWD transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

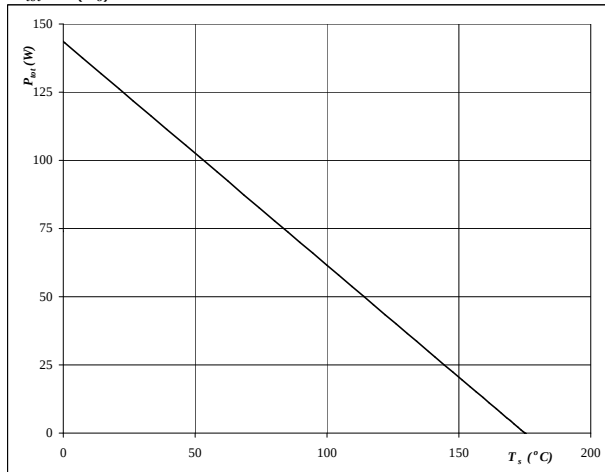
**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 1,22 \text{ K/W}$$

**figure 27.** FWD**Power dissipation as a function of heatsink temperature**

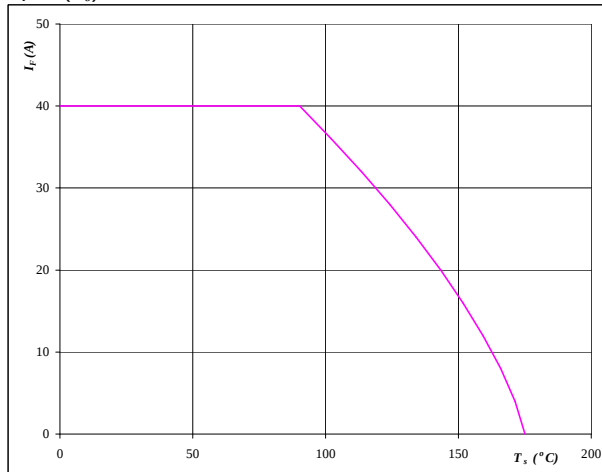
$$P_{tot} = f(T_s)$$

**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 28.** FWD**Forward current as a function of heatsink temperature**

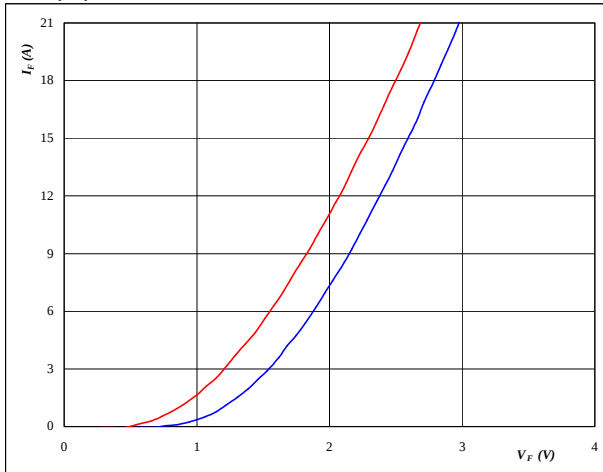
$$I_F = f(T_s)$$

**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**Buck Inverse Diode****figure 1.** FWD**Typical FWD forward current as a function of forward voltage**

$$I_F = f(V_F)$$

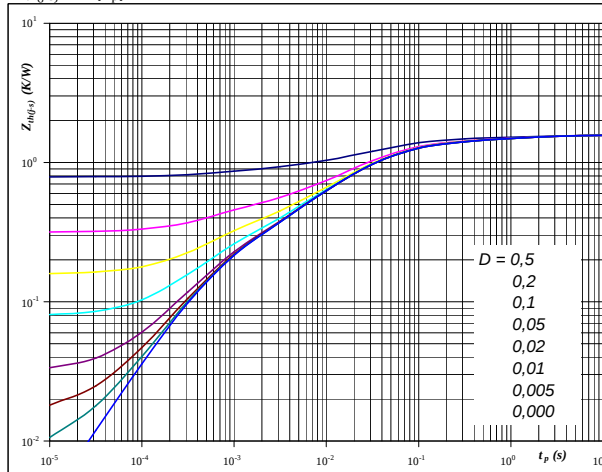
**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

$$t_p = 250 \text{ } \mu\text{s}$$

**figure 2.** FWD**FWD transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

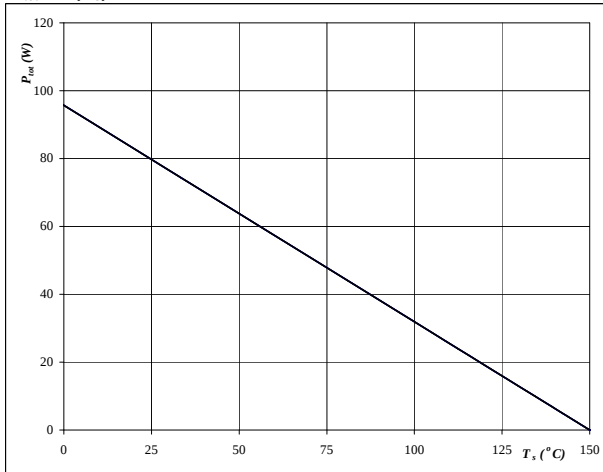
**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 1,57 \text{ K/W}$$

**figure 3.** FWD**Power dissipation as a function of heatsink temperature**

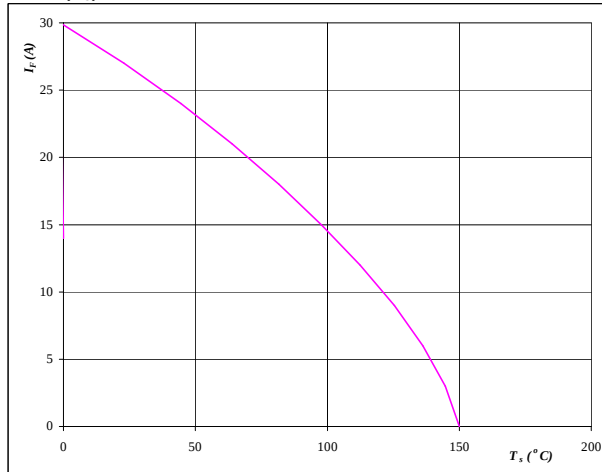
$$P_{tot} = f(T_s)$$

**At**

$$T_j = 150 \text{ } ^\circ\text{C}$$

**figure 4.** FWD**Forward current as a function of heatsink temperature**

$$I_F = f(T_s)$$

**At**

$$T_j = 150 \text{ } ^\circ\text{C}$$

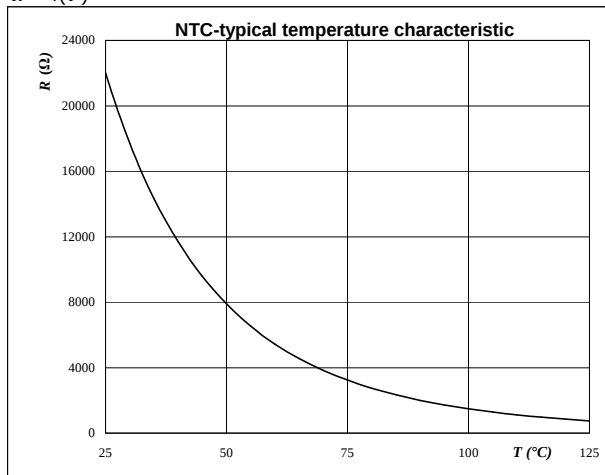


## Thermistor

**figure 1.** Thermistor

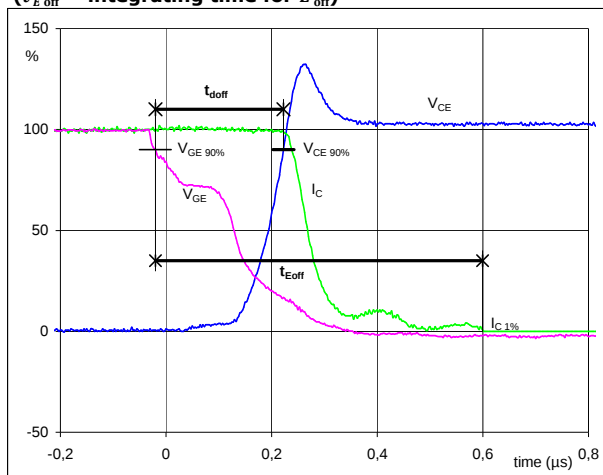
**Typical NTC characteristic  
as a function of temperature**

$$R = f(T)$$

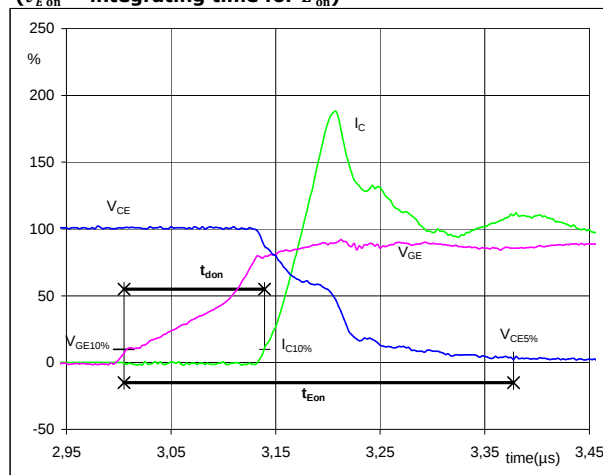


**Buck Switching Characteristics****General conditions**

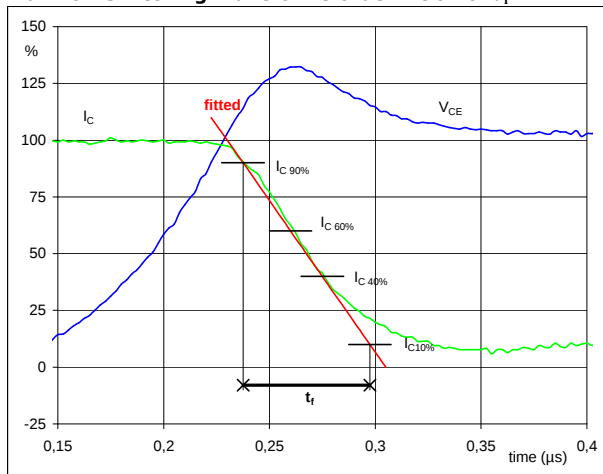
|            |   |            |
|------------|---|------------|
| $T_j$      | = | 125 °C     |
| $R_{gon}$  | = | 4 $\Omega$ |
| $R_{goff}$ | = | 4 $\Omega$ |

**figure 1.****IGBT****Turn-off Switching Waveforms & definition of  $t_{doff}$   $t_{Eoff}$**   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )

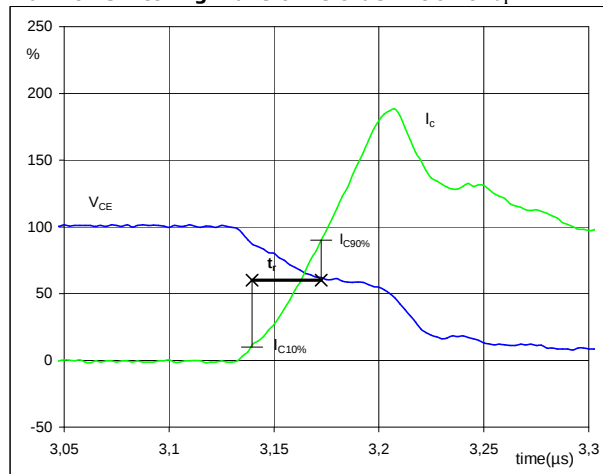
|                   |      |         |
|-------------------|------|---------|
| $V_{GE}$ (0%) =   | -15  | V       |
| $V_{GE}$ (100%) = | 15   | V       |
| $V_C$ (100%) =    | 350  | V       |
| $I_C$ (100%) =    | 149  | A       |
| $t_{doff}$ =      | 0,25 | $\mu$ s |
| $t_{Eoff}$ =      | 0,62 | $\mu$ s |

**figure 2.****IGBT****Turn-on Switching Waveforms & definition of  $t_{don}$   $t_{Eon}$**   
( $t_{Eon}$  = integrating time for  $E_{on}$ )

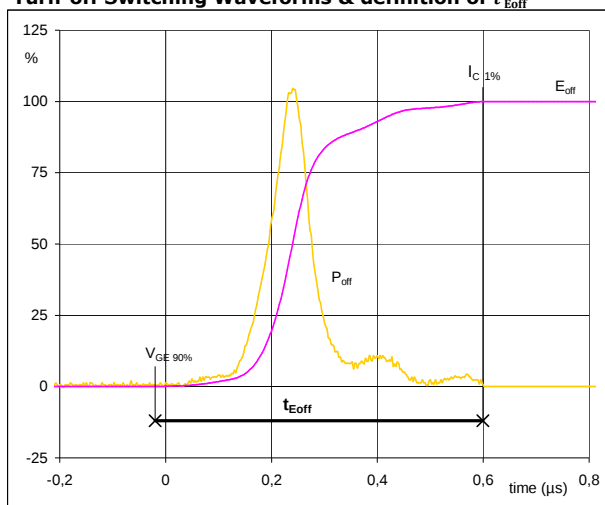
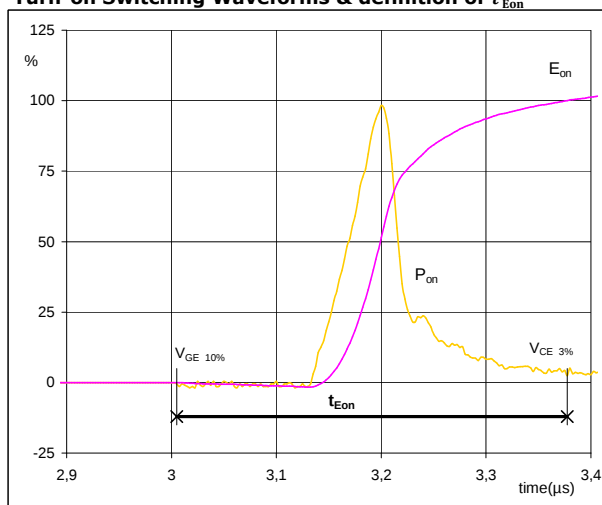
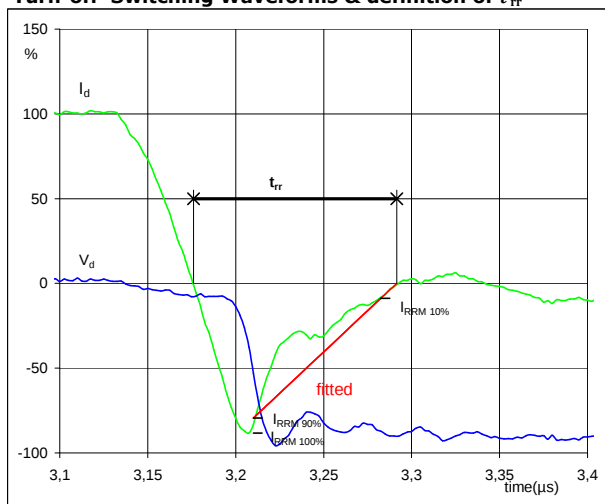
|                   |      |         |
|-------------------|------|---------|
| $V_{GE}$ (0%) =   | -15  | V       |
| $V_{GE}$ (100%) = | 15   | V       |
| $V_C$ (100%) =    | 350  | V       |
| $I_C$ (100%) =    | 149  | A       |
| $t_{don}$ =       | 0,13 | $\mu$ s |
| $t_{Eon}$ =       | 0,37 | $\mu$ s |

**figure 3.****IGBT****Turn-off Switching Waveforms & definition of  $t_f$** 

|                |      |         |
|----------------|------|---------|
| $V_C$ (100%) = | 350  | V       |
| $I_C$ (100%) = | 149  | A       |
| $t_f$ =        | 0,06 | $\mu$ s |

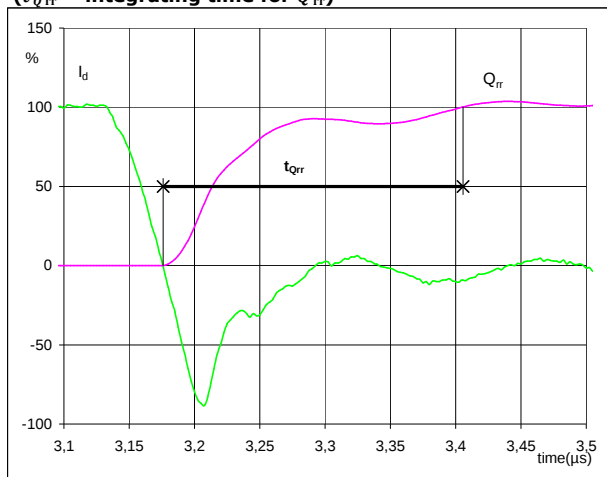
**figure 4.****IGBT****Turn-on Switching Waveforms & definition of  $t_r$** 

|                |      |         |
|----------------|------|---------|
| $V_C$ (100%) = | 350  | V       |
| $I_C$ (100%) = | 149  | A       |
| $t_r$ =        | 0,03 | $\mu$ s |

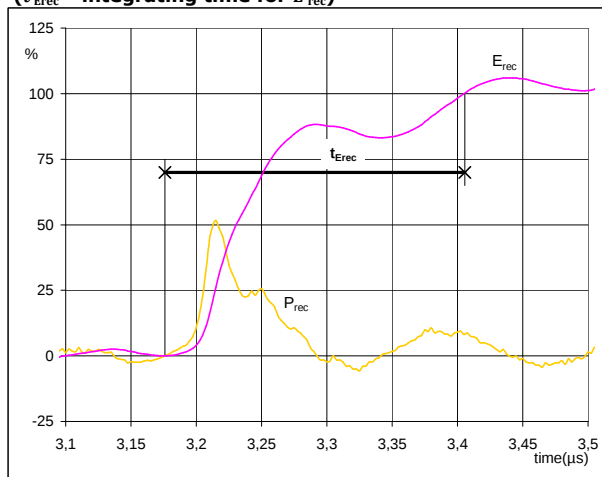
**Buck Switching Characteristics****figure 5. IGBT****Turn-off Switching Waveforms & definition of  $t_{Eoff}$**  $P_{off} (100\%) = 52,08 \text{ kW}$  $E_{off} (100\%) = 5,81 \text{ mJ}$  $t_{Eoff} = 0,62 \text{ μs}$ **figure 6. IGBT****Turn-on Switching Waveforms & definition of  $t_{Eon}$**  $P_{on} (100\%) = 52,08 \text{ kW}$  $E_{on} (100\%) = 3,36 \text{ mJ}$  $t_{Eon} = 0,37 \text{ μs}$ **figure 7. FWD****Turn-off Switching Waveforms & definition of  $t_{rr}$**  $V_d (100\%) = 350 \text{ V}$  $I_d (100\%) = 149 \text{ A}$  $I_{RRM} (100\%) = -133 \text{ A}$  $t_{rr} = 0,11 \text{ μs}$



## Buck Switching Characteristics

**figure 8.** FWD**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )

$I_d$  (100%) = 149 A  
 $Q_{rr}$  (100%) = 6,41  $\mu$ C  
 $t_{Qrr}$  = 0,23  $\mu$ s

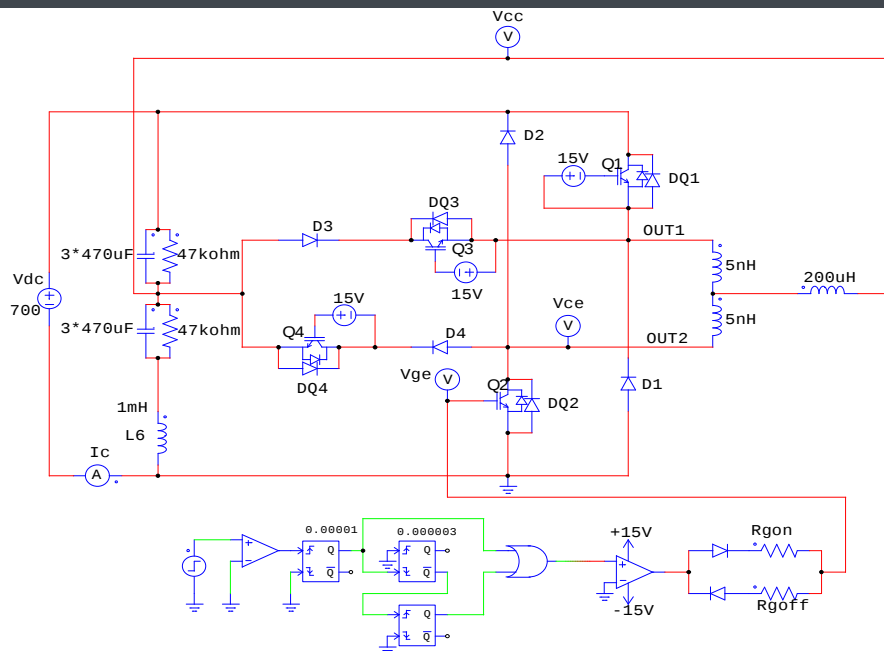
**figure 9.** FWD**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
( $t_{Erec}$  = integrating time for  $E_{rec}$ )

$P_{rec}$  (100%) = 52,08 kW  
 $E_{rec}$  (100%) = 1,25 mJ  
 $t_{Erec}$  = 0,23  $\mu$ s

## Buck switching measurement circuit

**figure 10.**

IGBT

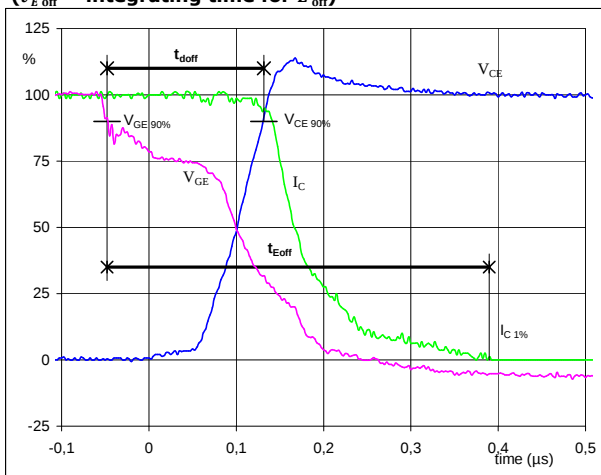




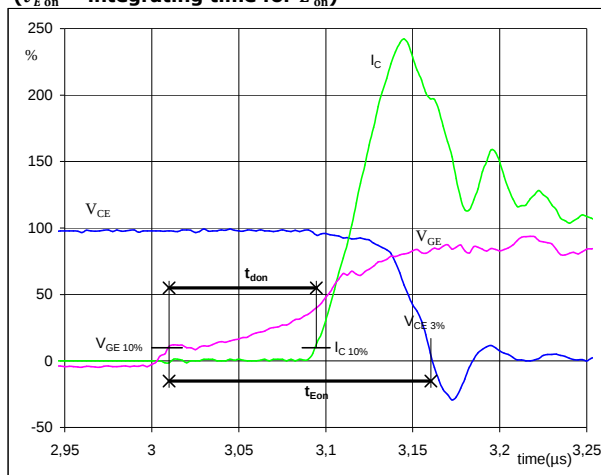
## Boost Switching Characteristics

### General conditions

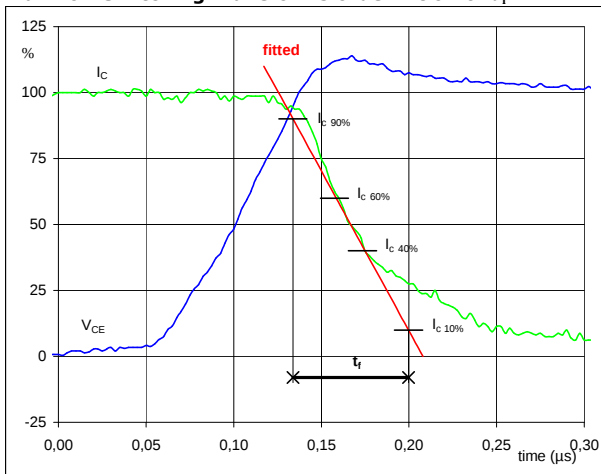
|            |   |            |
|------------|---|------------|
| $T_j$      | = | 125 °C     |
| $R_{gon}$  | = | 4 $\Omega$ |
| $R_{goff}$ | = | 4 $\Omega$ |

**figure 1.****IGBT****Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$**   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )

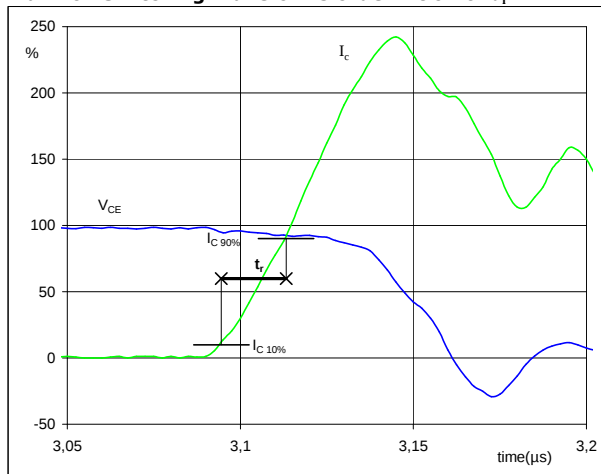
|                  |   |      |         |
|------------------|---|------|---------|
| $V_{GE} (0\%)$   | = | -15  | V       |
| $V_{GE} (100\%)$ | = | 15   | V       |
| $V_C (100\%)$    | = | 350  | V       |
| $I_C (100\%)$    | = | 100  | A       |
| $t_{doff}$       | = | 0,18 | $\mu s$ |
| $t_{Eoff}$       | = | 0,44 | $\mu s$ |

**figure 2.****IGBT****Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$**   
( $t_{Eon}$  = integrating time for  $E_{on}$ )

|                  |   |      |         |
|------------------|---|------|---------|
| $V_{GE} (0\%)$   | = | -15  | V       |
| $V_{GE} (100\%)$ | = | 15   | V       |
| $V_C (100\%)$    | = | 350  | V       |
| $I_C (100\%)$    | = | 100  | A       |
| $t_{don}$        | = | 0,10 | $\mu s$ |
| $t_{Eon}$        | = | 0,15 | $\mu s$ |

**figure 3.****IGBT****Turn-off Switching Waveforms & definition of  $t_f$** 

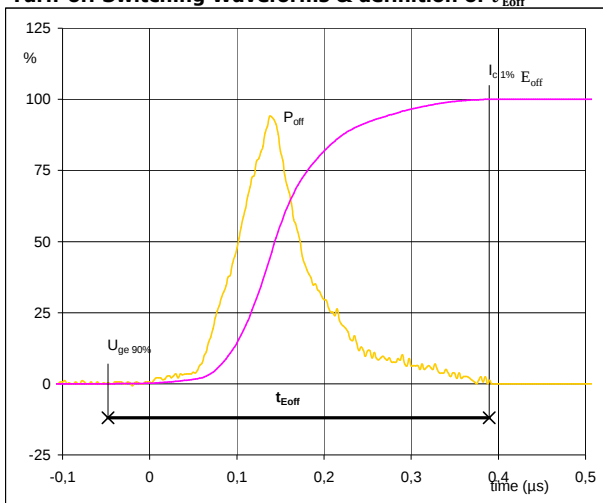
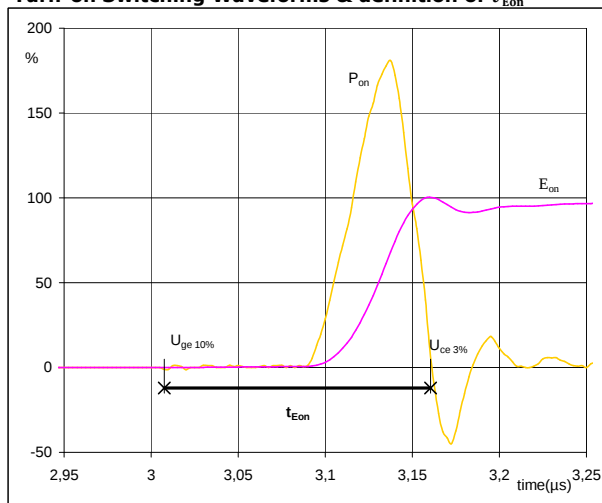
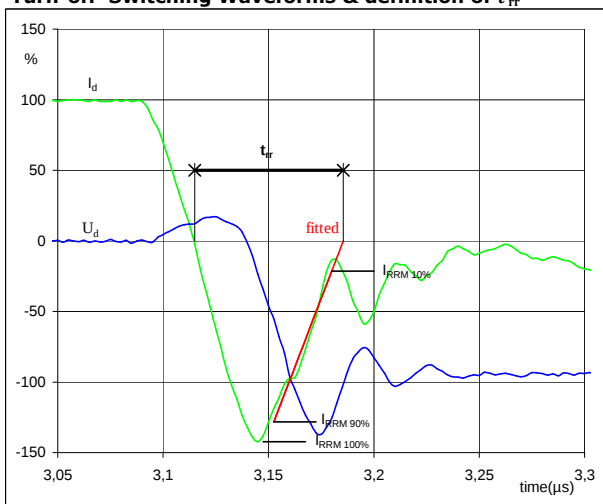
|               |   |       |         |
|---------------|---|-------|---------|
| $V_C (100\%)$ | = | 350   | V       |
| $I_C (100\%)$ | = | 100   | A       |
| $t_f$         | = | 0,064 | $\mu s$ |

**figure 4.****IGBT****Turn-on Switching Waveforms & definition of  $t_r$** 

|               |   |       |         |
|---------------|---|-------|---------|
| $V_C (100\%)$ | = | 350   | V       |
| $I_C (100\%)$ | = | 100   | A       |
| $t_r$         | = | 0,019 | $\mu s$ |

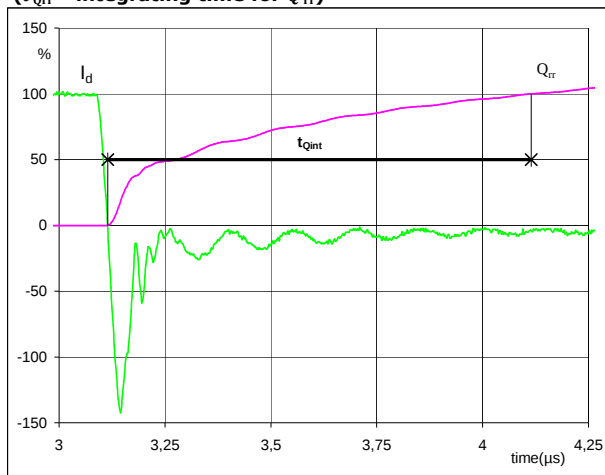


## Boost Switching Characteristics

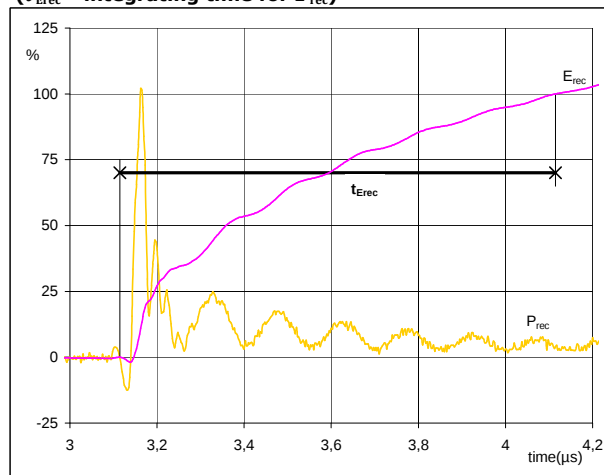
**figure 5. IGBT****Turn-off Switching Waveforms & definition of  $t_{Eoff}$**  $P_{off} (100\%) = 34,96 \text{ kW}$  $E_{off} (100\%) = 3,32 \text{ mJ}$  $t_{Eoff} = 0,44 \text{ μs}$ **figure 6. IGBT****Turn-on Switching Waveforms & definition of  $t_{Eon}$**  $P_{on} (100\%) = 34,964 \text{ kW}$  $E_{on} (100\%) = 1,52 \text{ mJ}$  $t_{Eon} = 0,15 \text{ μs}$ **figure 7. FWD****Turn-off Switching Waveforms & definition of  $t_{rr}$**  $V_d (100\%) = 350 \text{ V}$  $I_d (100\%) = 100 \text{ A}$  $I_{RRM} (100\%) = -142 \text{ A}$  $t_{rr} = 0,07 \text{ μs}$



## Boost Switching Characteristics

**figure 8.** FWD**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )

$I_d$  (100%) = 100 A  
 $Q_{rr}$  (100%) = 12,71  $\mu$ C  
 $t_{Qint}$  = 1,00  $\mu$ s

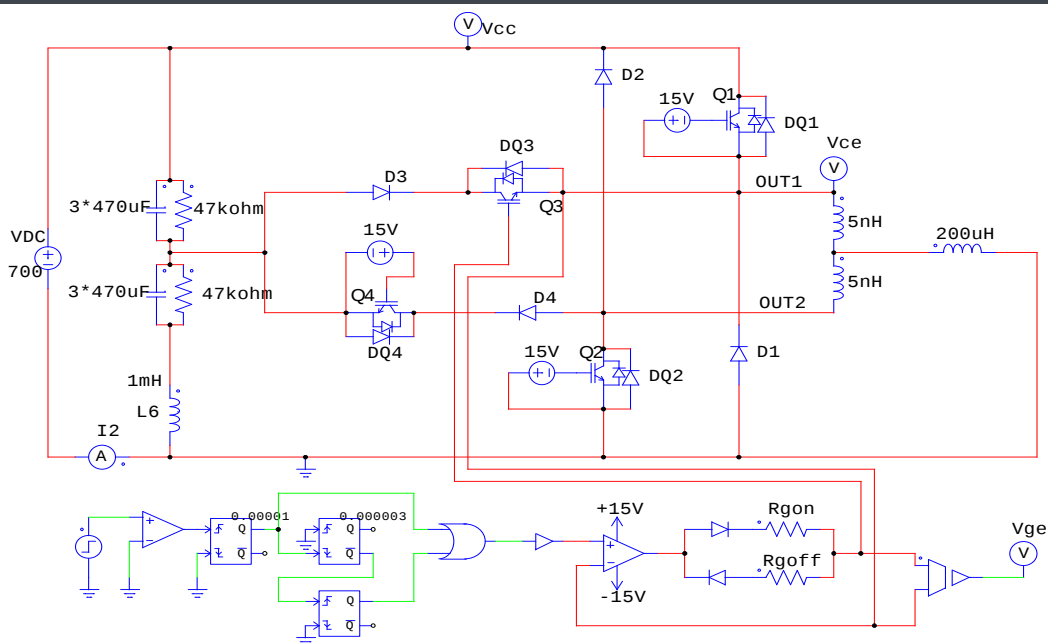
**figure 9.** FWD**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
( $t_{Erec}$  = integrating time for  $E_{rec}$ )

$P_{rec}$  (100%) = 34,96 kW  
 $E_{rec}$  (100%) = 3,61 mJ  
 $t_{Erec}$  = 1,00  $\mu$ s

## Boost switching measurement circuit

**figure 10.**

IGBT

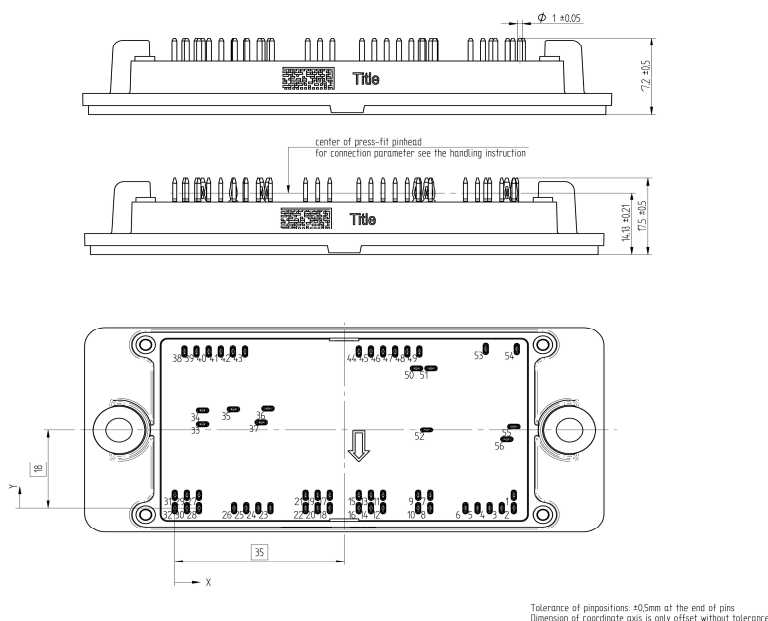


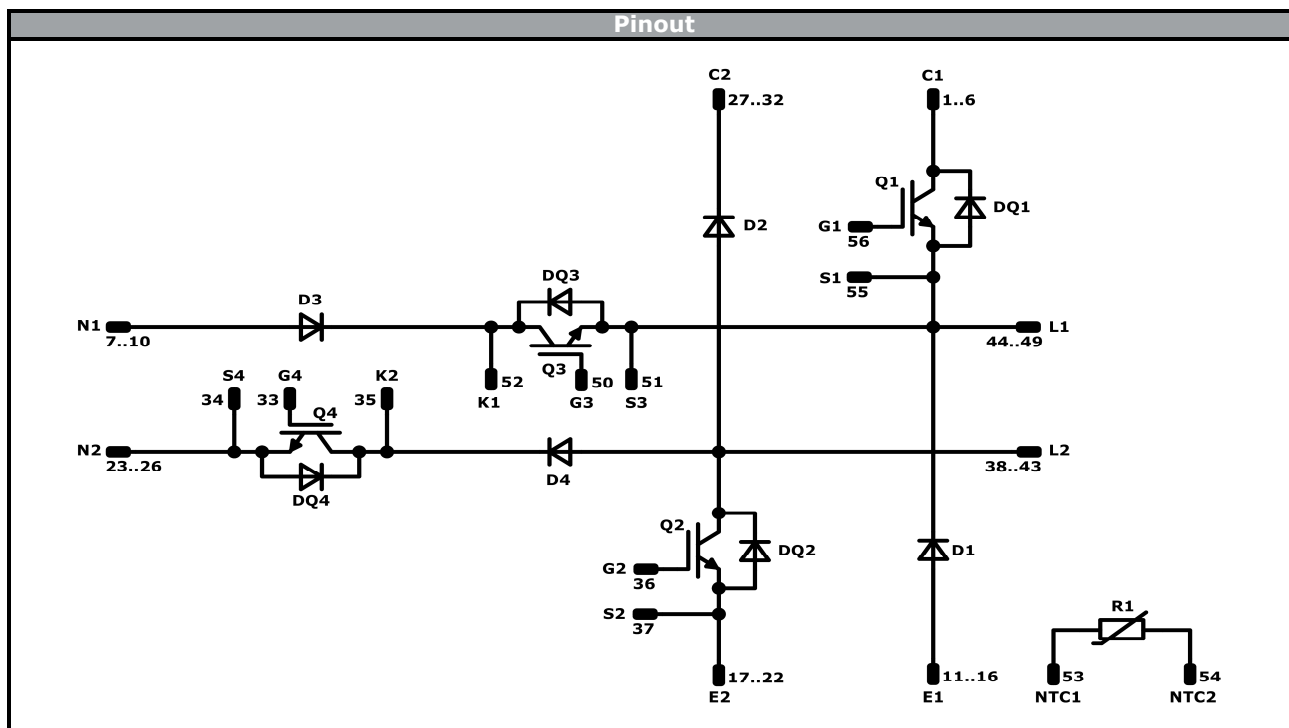
**Ordering Code & Marking**

| Version                                                                           |  | Ordering Code              |          |            |          |           |       |        |
|-----------------------------------------------------------------------------------|--|----------------------------|----------|------------|----------|-----------|-------|--------|
| without thermal paste with solder pins 13mm housing                               |  | 30-FT12NMA160SH02-M669F28  |          |            |          |           |       |        |
| without thermal paste with press-fit pins 13mm housing                            |  | 30-PT12NMA160SH02-M669F28Y |          |            |          |           |       |        |
|                                                                                   |  |                            |          |            |          |           |       |        |
|  |  | Text                       | VIN      | Date code  | Name&Ver | UL        | Lot   | Serial |
|                                                                                   |  |                            | VIN      | WWYY       | NNNNNVV  | UL        | LLLLL | SSSS   |
|                                                                                   |  | Datamatrix                 | Type&Ver | Lot number | Serial   | Date code |       |        |
|                                                                                   |  |                            | TTTTTTTV | LLLLL      | SSSS     | WWYY      |       |        |

**Outline**

| Pin table |       |   |          | Pin table |       |       |          |
|-----------|-------|---|----------|-----------|-------|-------|----------|
| Pin       | X     | Y | Function | Pin       | X     | Y     | Function |
| 1         | 70    | 3 | C1       | 29        | 2,5   | 3     | C2       |
| 2         | 70    | 0 | C1       | 30        | 2,5   | 0     | C2       |
| 3         | 67,5  | 0 | C1       | 31        | 0     | 3     | C2       |
| 4         | 65    | 0 | C1       | 32        | 0     | 0     | C2       |
| 5         | 62,5  | 0 | C1       | 33        | 5,75  | 19,45 | G4       |
| 6         | 60    | 0 | C1       | 34        | 5,75  | 22,45 | S4       |
| 7         | 52,75 | 3 | N1       | 35        | 12,1  | 22,7  | K2       |
| 8         | 52,75 | 0 | N1       | 36        | 19,25 | 22,85 | G2       |
| 9         | 50,25 | 3 | N1       | 37        | 17,85 | 19,85 | S2       |
| 10        | 50,25 | 0 | N1       | 38        | 2     | 36    | L2       |
| 11        | 43    | 3 | E1       | 39        | 4,5   | 36    | L2       |
| 12        | 43    | 0 | E1       | 40        | 7     | 36    | L2       |
| 13        | 40,5  | 3 | E1       | 41        | 9,5   | 36    | L2       |
| 14        | 40,5  | 0 | E1       | 42        | 12    | 36    | L2       |
| 15        | 38    | 3 | E1       | 43        | 14,5  | 36    | L2       |
| 16        | 38    | 0 | E1       | 44        | 38    | 36    | L1       |
| 17        | 32    | 3 | E2       | 45        | 40,5  | 36    | L1       |
| 18        | 32    | 0 | E2       | 46        | 43    | 36    | L1       |
| 19        | 29,5  | 3 | E2       | 47        | 45,5  | 36    | L1       |
| 20        | 29,5  | 0 | E2       | 48        | 48    | 36    | L1       |
| 21        | 27    | 3 | E2       | 49        | 50,5  | 36    | L1       |
| 22        | 27    | 0 | E2       | 50        | 49,9  | 32    | G3       |
| 23        | 19,75 | 0 | N2       | 51        | 52,9  | 32    | S3       |
| 24        | 17,25 | 0 | N2       | 52        | 52    | 18,1  | K1       |
| 25        | 14,75 | 0 | N2       | 53        | 64,2  | 36,6  | NTC1     |
| 26        | 12,25 | 0 | N2       | 54        | 70,6  | 36,55 | NTC2     |
| 27        | 5     | 3 | C2       | 55        | 70    | 18,9  | S1       |
| 28        | 5     | 0 | C2       | 56        | 68,55 | 15,9  | G1       |





| Identification |           |         |         |                            |         |
|----------------|-----------|---------|---------|----------------------------|---------|
| ID             | Component | Voltage | Current | Function                   | Comment |
| Q1, Q2         | IGBT      | 1200 V  | 160 A   | Buck Switch                |         |
| DQ1, DQ2       | FWD       | 1200 V  | 7 A     | Buck Sw. Protection Diode  |         |
| D3, D4         | FWD       | 650 V   | 100 A   | Buck Diode                 |         |
| Q3, Q4         | IGBT      | 650 V   | 100 A   | Boost Switch               |         |
| DQ3, DQ4       | FWD       | 650 V   | 60 A    | Boost Sw. Protection Diode |         |
| D1, D2         | FWD       | 1200 V  | 60 A    | Boost Diode                |         |
| R1             | NTC       |         |         | Thermistor                 |         |

| Packaging instruction             |           |                  |                |
|-----------------------------------|-----------|------------------|----------------|
| Standard packaging quantity (SPQ) | <b>36</b> | >SPQ    Standard | <SPQ    Sample |

| Handling instruction                                                        |
|-----------------------------------------------------------------------------|
| Handling instructions for <i>flow</i> 2 packages see vincotech.com website. |

| Package data                                                       |
|--------------------------------------------------------------------|
| Package data for <i>flow</i> 2 packages see vincotech.com website. |

| UL recognition and file number                                                                                                                                                                                      |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.  |

| Document No.:                   | Date:        | Modification:          | Pages  |
|---------------------------------|--------------|------------------------|--------|
| 30-FT12NMA160SH02-M669F28-D5-14 | 06 Sep. 2017 | Press-fit option added | 1 , 30 |

#### DISCLAIMER

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.